US Patent & Trademark Office Patent Public Search | Text View

United States Patent

Kind Code

B2
Date of Patent

August 19, 2025

Inventor(s)

Dubelman; Meredith Elissa et al.

Resin management system for additive manufacturing

Abstract

An additive manufacturing apparatus includes a stage configured to hold a component. A radiant energy device is operable to generate and project radiant energy in a patterned image. An actuator is configured to change a relative position of the stage relative to the radiant energy device. A resin management system includes a material deposition assembly upstream configured to deposit a resin on a resin support. The material deposition assembly includes a reservoir configured to retain a first volume of the resin and define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction. The material deposition assembly further includes a vessel positioned above the reservoir in a Z-axis direction and configured to store a second volume of the resin. In addition, the material deposition assembly includes a conduit configured to direct the resin from the vessel to the reservoir.

Inventors: Dubelman; Meredith Elissa (Liberty Township, OH), Muhlenkamp; Trent William

(Cincinnati, OH), Dickson; Kevin Robert (Dayton, OH), Barnhill; Christopher David

(Cincinnati, OH), Thompson; Brian Thomas (Loveland, OH)

Applicant: General Electric Company (Schenectady, NY); Unison Industries, LLC (Jacksonville,

FL)

Family ID: 1000008764945

Assignee: General Electric Company (Evendale, OH); Unison Industries, LLC (Jacksonville,

FL)

Appl. No.: 18/497369

Filed: October 30, 2023

Prior Publication Data

Document IdentifierUS 20240059008 A1

Publication Date
Feb. 22, 2024

Related U.S. Application Data

continuation parent-doc US 17371484 20210709 US 11826950 child-doc US 18497369

Publication Classification

Int. Cl.: B29C64/124 (20170101); B29C64/214 (20170101); B29C64/232 (20170101); B29C64/241 (20170101); B29C64/245 (20170101); B29C64/255 (20170101); B29C64/264 (20170101); B29C64/393 (20170101); B33Y10/00 (20150101); B33Y30/00 (20150101); B33Y50/02 (20150101)

U.S. Cl.:

CPC **B29C64/124** (20170801); **B29C64/214** (20170801); **B29C64/232** (20170801); **B29C64/241** (20170801); **B29C64/245** (20170801); **B29C64/255** (20170801); **B29C64/264** (20170801); **B29C64/393** (20170801); **B33Y10/00** (20141201); **B33Y30/00** (20141201); **B33Y50/02** (20141201);

Field of Classification Search

CPC: B29C (64/124); B29C (64/129); B29C (64/135); B29C (64/321); B29C (64/329); B29C (64/393); B29C (64/255); B33Y (10/00); B33Y (30/00); B33Y (50/02)

References Cited

U.S. PATENT DOCUMENTS

U.S. PATENT DUC	LUMENIS			
Patent No.	Issued Date	Patentee Name	U.S. Cl.	CPC
1990749	12/1934	Phillips et al.	N/A	N/A
2259517	12/1940	Drenkard, Jr.	N/A	N/A
3264103	12/1965	Cohen et al.	N/A	N/A
3395014	12/1967	Cohen et al.	N/A	N/A
3486482	12/1968	Hunger	N/A	N/A
3710846	12/1972	Properzi	N/A	N/A
3875067	12/1974	DeSorgo et al.	N/A	N/A
3991149	12/1975	Hurwitt	N/A	N/A
4041476	12/1976	Swainson	N/A	N/A
4292827	12/1980	Waugh	N/A	N/A
4575330	12/1985	Hull	N/A	N/A
4752498	12/1987	Fudim	N/A	N/A
4945032	12/1989	Murphy et al.	N/A	N/A
5015312	12/1990	Kinzie	N/A	N/A
5026146	12/1990	Hug et al.	N/A	N/A
5031120	12/1990	Pomerantz et al.	N/A	N/A
5058988	12/1990	Spence et al.	N/A	N/A
5059021	12/1990	Spence et al.	N/A	N/A
5088047	12/1991	Bynum	N/A	N/A
5094935	12/1991	Vassiliou et al.	N/A	N/A
5096530	12/1991	Cohen	N/A	N/A
5104592	12/1991	Hull et al.	N/A	N/A
5123734	12/1991	Spence et al.	N/A	N/A
5126259	12/1991	Weiss et al.	N/A	N/A
5126529	12/1991	Weiss et al.	N/A	N/A
5133987	12/1991	Spence et al.	N/A	N/A
5162167	12/1991	Minh et al.	N/A	N/A
5174931	12/1991	Almquist et al.	N/A	N/A

5182055 12/1992 Allison et al. N/A N/A 5183598 12/1992 Helle et al. N/A N/A 5192559 12/1992 Hull et al. N/A N/A 5203944 12/1992 Prinz et al. N/A N/A 5207371 12/1992 Sachs et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Hull N/A N/A 5236612 12/1992 Mitcham et al. N/A N/A 5247180 12/1992 Mitcham et al. N/A N/A 5248456 12/1992 Evans, Jr. et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 544782 12/1994 Hull et al. N/A N/A 544782 12/1994 Hull et al. N/A N/A 544782 12/1994 Hull et al. </th <th>5175077</th> <th>12/1991</th> <th>Grossa</th> <th>N/A</th> <th>N/A</th>	5175077	12/1991	Grossa	N/A	N/A
5183598 12/1992 Helle et al. N/A N/A 5192559 12/1992 Hull et al. N/A N/A 5203944 12/1992 Sachs et al. N/A N/A 5204055 12/1992 Prinz et al. N/A N/A 5207371 12/1992 Prinz et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Wastliou et al. N/A N/A 5247180 12/1992 Vassiliou et al. N/A N/A 5247180 12/1992 Evans, Jr. et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5347380 12/1993 Sachs et al. N/A N/A 5447822 12/1994 Cima et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 54460758 12/1994 <					
5192559 12/1992 Hull et al. N/A N/A 5203044 12/1992 Prinz et al. N/A N/A 5204055 12/1992 Prinz et al. N/A N/A 5207371 12/1992 Prinz et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Wassiliou et al. N/A N/A 5248456 12/1992 Mitcham et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 531471 12/1993 Baccini N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5447822 12/1994 Knapp et al. N/A N/A 54060758 12/1994 Knapp et al. N/A N/A 5607540 12/1996 Onis					
5204055 12/1992 Sachs et al. N/A N/A 5207371 12/1992 Prinz et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Hull N/A N/A 5236812 12/1992 Vassiliou et al. N/A N/A 5247180 12/1992 Evans, Jr. et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340565 12/1994 Cima et al. N/A N/A 54373380 12/1994 Cima et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5447622 12/1994 Knapp et al. N/A N/A 54060758 12/1994 Langer et al. N/A N/A 54060758 12/1996 On					
5207371 12/1992 Prinz et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Hull N/A N/A 5236812 12/1992 Witcham et al. N/A N/A 5247180 12/1992 Evans, Jr. et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5258146 12/1993 Baccini N/A N/A 5314711 12/1993 Sachs et al. N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 5347380 12/1994 Cima et al. N/A N/A 5443025 12/1994 Hull et al. N/A N/A 5447822 12/1994 Knapp et al. N/A N/A 5406058 12/1994 Knapp et al. N/A N/A 5406082 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Vinson et	5203944	12/1992	Prinz et al.	N/A	N/A
5207371 12/1992 Prinz et al. N/A N/A 5236326 12/1992 Grossa N/A N/A 5236637 12/1992 Hull N/A N/A 5236812 12/1992 Witcham et al. N/A N/A 5247180 12/1992 Evans, Jr. et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5258146 12/1993 Baccini N/A N/A 5314711 12/1993 Sachs et al. N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 5347380 12/1994 Cima et al. N/A N/A 5443025 12/1994 Hull et al. N/A N/A 5447822 12/1994 Knapp et al. N/A N/A 5406058 12/1994 Knapp et al. N/A N/A 5406082 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Vinson et					
52366326 12/1992 Grossa N/A N/A 5236637 12/1992 Hull N/A N/A 5236812 12/1992 Vassiliou et al. N/A N/A 5247180 12/1992 Mitcham et al. N/A N/A 5248456 12/1992 Evans, Jr. et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Knapp et al. N/A N/A 545069 12/1994 Knapp et al. N/A N/A 54060758 12/1994 Knapp et al. N/A N/A 5407540 12/1996 Onishi N/A N/A 5607540 12/1996 Vinson et al. N/A N/A 5665210 12/1996 Orishi					
5236637 12/1992 Hull N/A N/A 5236812 12/1992 Vassiliou et al. N/A N/A 5247180 12/1992 Mitcham et al. N/A N/A 5248456 12/1992 Evans, Jr. et al. N/A N/A 5248456 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Sachs et al. N/A N/A 5340565 12/1994 Cima et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Langer et al. N/A N/A 5407540 12/1995 Quadir et al. N/A N/A 5607620 12/1996 Onishi N/A N/A 562019 12/1996 Onishi N/A N/A 5665020 12/1996 Onishi </td <td>5236326</td> <td>12/1992</td> <td>Grossa</td> <td>N/A</td> <td>N/A</td>	5236326	12/1992	Grossa	N/A	N/A
5247180 12/1992 Mitcham et al. N/A N/A 5248456 12/1992 Evans, Jr. et al. N/A N/A 5258146 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1994 Cima et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5450699 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5610824 12/1996 Onishi N/A N/A 5626919 12/1996 Vinson et al. N/A N/A 56650260 12/1996 Onishi N/A N/A 5666401 12/1996 Bredt N/A N/A 5697043 12/1996 Baskaran et a	5236637	12/1992		N/A	N/A
5248456 12/1992 Evans, Jr. et al. N/A N/A 5258146 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1994 Cima et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Knapp et al. N/A N/A 54560758 12/1994 Langer et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5687401 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Jacobs et al. </td <td>5236812</td> <td>12/1992</td> <td></td> <td>N/A</td> <td>N/A</td>	5236812	12/1992		N/A	N/A
5248456 12/1992 Evans, Jr. et al. N/A N/A 5258146 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1994 Cima et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Knapp et al. N/A N/A 54560758 12/1994 Langer et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5687040 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Jacobs et al. </td <td></td> <td></td> <td>Mitcham et al.</td> <td>N/A</td> <td></td>			Mitcham et al.	N/A	
5258146 12/1992 Almquist et al. N/A N/A 5314711 12/1993 Baccini N/A N/A 5340656 12/1993 Sachs et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Hull et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Knapp et al. N/A N/A 5460758 12/1994 Langer et al. N/A N/A 5400758 12/1995 Quadir et al. N/A N/A 560662 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Bredt N/A N/A 5665401 12/1996 Bredt N/A N/A 5688464 12/1996 Baskaran et al.	5248456	12/1992	Evans, Jr. et al.	N/A	N/A
5314711 12/1993 Baccini N/A N/A 5340656 12/1994 Cima et al. N/A N/A 5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Narukawa et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 545069 12/1994 Langer et al. N/A N/A 5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Onishi N/A N/A 5650260 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 568404 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5718279 12/1997 Menhennett et al.	5258146	12/1992		N/A	N/A
5387380 12/1994 Cima et al. N/A N/A 5432045 12/1994 Narukawa et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Knapp et al. N/A N/A 5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Chapman et al. N/A N/A 5626919 12/1996 Onishi N/A N/A 5650260 12/1996 Onishi N/A N/A 5665401 12/1996 Bredt N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5746833 12/1997 Saoth et al. N/A N/A 5764521 12/1997 Batchelder et	5314711	12/1993	-	N/A	N/A
5432045 12/1994 Narukawa et al. N/A N/A 5447822 12/1994 Hull et al. N/A N/A 544069 12/1994 Knapp et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Onishi N/A N/A 5650260 12/1996 Bredt N/A N/A 5660621 12/1996 Bredt N/A N/A 568404 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5746833 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5824184 12/1997 Batchelder	5340656	12/1993	Sachs et al.	N/A	N/A
5447822 12/1994 Hull et al. N/A N/A 5454069 12/1994 Knapp et al. N/A N/A 5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5610824 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Bredt N/A N/A 5665021 12/1996 Bredt N/A N/A 5665401 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5807437 12/1997 Batchelder e	5387380	12/1994	Cima et al.	N/A	N/A
5454069 12/1994 Knapp et al. N/A N/A 5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Bredt N/A N/A 5660621 12/1996 Bredt N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5718279 12/1997 Menhennett et al. N/A N/A 5746833 12/1997 Sach et al. N/A N/A 5807437 12/1997 Batchelder et al. N/A N/A 581465 12/1997 B	5432045	12/1994	Narukawa et al.	N/A	N/A
5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Bredt N/A N/A 5665401 12/1996 Bredt N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Jacobs et al. N/A N/A 5718279 12/1997 Menhennett et al. N/A N/A 5746833 12/1997 Saoth et al. N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5807437 12/1997 Redt N/A N/A 5807437 12/1997 Redt	5447822	12/1994	Hull et al.	N/A	N/A
5460758 12/1994 Langer et al. N/A N/A 5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Bredt N/A N/A 5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Jacobs et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5807437 12/1998	5454069	12/1994	Knapp et al.	N/A	N/A
5496682 12/1995 Quadir et al. N/A N/A 5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5610824 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5665401 12/1996 Jacobs et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5746833 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 585547 12/1998 <td< td=""><td>5460758</td><td>12/1994</td><td></td><td>N/A</td><td>N/A</td></td<>	5460758	12/1994		N/A	N/A
5607540 12/1996 Onishi N/A N/A 5610824 12/1996 Vinson et al. N/A N/A 5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Onishi N/A N/A 56650261 12/1996 Bredt N/A N/A 5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5886058 12/1998 Kathrein et	5496682	12/1995	_	N/A	N/A
5626919 12/1996 Chapman et al. N/A N/A 5650260 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Batchelder et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 589547 12/1998 Batchelder et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5945058 12/1998 <td>5607540</td> <td>12/1996</td> <td>-</td> <td>N/A</td> <td>N/A</td>	5607540	12/1996	-	N/A	N/A
5650260 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Baskaran et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5895547 12/1998 Batchelder et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998	5610824	12/1996	Vinson et al.	N/A	N/A
5650260 12/1996 Onishi N/A N/A 5660621 12/1996 Bredt N/A N/A 5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Baskaran et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Batchelder et al. N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5895547 12/1998 Batchelder et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998	5626919	12/1996	Chapman et al.	N/A	N/A
5665401 12/1996 Serbin et al. N/A N/A 5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 586058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 59900207 12/1998 Danforth et al. N/A N/A 5945058 12/1998 Sachs et al. N/A N/A 5945058 12/1998		12/1996	-	N/A	
5688464 12/1996 Jacobs et al. N/A N/A 5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Kamijo et al. N/A N/A 5824184 12/1997 Bredt N/A N/A 5851465 12/1997 Bredt N/A N/A 5895547 12/1998 Batchelder et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5980813 12/1998 Manners et al. N/A N/A 5985204 12/1998	5660621	12/1996	Bredt	N/A	N/A
5693144 12/1996 Jacobs et al. N/A N/A 5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5980813 12/1998 Manners et al. N/A N/A 5985204 12/1998 <td>5665401</td> <td>12/1996</td> <td>Serbin et al.</td> <td>N/A</td> <td>N/A</td>	5665401	12/1996	Serbin et al.	N/A	N/A
5697043 12/1996 Baskaran et al. N/A N/A 5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5988561 12/1998 Marang et al. N/A N/A 5985204 12/1998<	5688464	12/1996	Jacobs et al.	N/A	N/A
5717599 12/1997 Menhennett et al. N/A N/A 5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Bredt N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Manners et al. N/A N/A 5945058 12/1998 Marners et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1999	5693144	12/1996	Jacobs et al.	N/A	N/A
5718279 12/1997 Saoth et al. N/A N/A 5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5968561 12/1998 Manners et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999	5697043	12/1996	Baskaran et al.	N/A	N/A
5746833 12/1997 Gerhardt N/A N/A 5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999	5717599	12/1997	Menhennett et al.	N/A	N/A
5764521 12/1997 Batchelder et al. N/A N/A 5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 598561 12/1998 Batchelder et al. N/A N/A 5985204 12/1998 Narang et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 610411 12/1999	5718279	12/1997	Saoth et al.	N/A	N/A
5807437 12/1997 Sachs et al. N/A N/A 5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999	5746833	12/1997	Gerhardt	N/A	N/A
5824184 12/1997 Kamijo et al. N/A N/A 5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 610411 12/1999 Clausen et al. N/A N/A 6146567 12/1999	5764521	12/1997	Batchelder et al.	N/A	N/A
5851465 12/1997 Bredt N/A N/A 5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6110411 12/1999 Fabbri N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5807437	12/1997	Sachs et al.	N/A	N/A
5866058 12/1998 Batchelder et al. N/A N/A 5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 6051179 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5824184	12/1997	Kamijo et al.	N/A	N/A
5895547 12/1998 Kathrein et al. N/A N/A 5900207 12/1998 Danforth et al. N/A N/A 5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5851465	12/1997	Bredt	N/A	N/A
590020712/1998Danforth et al.N/AN/A593900812/1998Comb et al.N/AN/A594067412/1998Sachs et al.N/AN/A594505812/1998Manners et al.N/AN/A596856112/1998Batchelder et al.N/AN/A598081312/1998Narang et al.N/AN/A598520412/1998Otsuka et al.N/AN/A605117912/1999HagenauN/AN/A606748012/1999Stuffle et al.N/AN/A61041112/1999Clausen et al.N/AN/A614656712/1999Sachs et al.N/AN/A	5866058	12/1998	Batchelder et al.	N/A	N/A
5939008 12/1998 Comb et al. N/A N/A 5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5895547	12/1998	Kathrein et al.	N/A	N/A
5940674 12/1998 Sachs et al. N/A N/A 5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5900207	12/1998	Danforth et al.	N/A	N/A
5945058 12/1998 Manners et al. N/A N/A 5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5939008	12/1998	Comb et al.	N/A	N/A
5968561 12/1998 Batchelder et al. N/A N/A 5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5940674	12/1998	Sachs et al.	N/A	N/A
5980813 12/1998 Narang et al. N/A N/A 5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5945058	12/1998	Manners et al.	N/A	N/A
5985204 12/1998 Otsuka et al. N/A N/A 6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5968561	12/1998	Batchelder et al.	N/A	N/A
6051179 12/1999 Hagenau N/A N/A 6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5980813	12/1998	Narang et al.	N/A	N/A
6067480 12/1999 Stuffle et al. N/A N/A 6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	5985204	12/1998	Otsuka et al.	N/A	N/A
6068367 12/1999 Fabbri N/A N/A 6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	6051179	12/1999	Hagenau	N/A	N/A
6110411 12/1999 Clausen et al. N/A N/A 6146567 12/1999 Sachs et al. N/A N/A	6067480	12/1999	Stuffle et al.	N/A	N/A
6146567 12/1999 Sachs et al. N/A N/A	6068367	12/1999	Fabbri	N/A	N/A
	6110411	12/1999	Clausen et al.	N/A	N/A
6193923 12/2000 Leyden et al. N/A N/A	6146567	12/1999	Sachs et al.	N/A	N/A
	6193923	12/2000	Leyden et al.	N/A	N/A

6200646	12/2000	Neckers et al.	N/A	N/A
6206672	12/2000	Grenda	N/A	N/A
6363606	12/2001	Johnson et al.	N/A	N/A
6375451	12/2001	Robinson et al.	N/A	N/A
6376148	12/2001	Liu et al.	N/A	N/A
6391245	12/2001	Smith	N/A	N/A
6399010	12/2001	Guertin et al.	N/A	N/A
6401002	12/2001	Jang et al.	N/A	N/A
6403002	12/2001	van der Geest	N/A	N/A
6436520	12/2001	Yamamoto	N/A	N/A
6450393	12/2001	Doumanidis et al.	N/A	N/A
6463349	12/2001	White et al.	N/A	N/A
6471800	12/2001	Jang et al.	N/A	N/A
6500378	12/2001	Smith	N/A	N/A
6512869	12/2002	Imayama et al.	N/A	N/A
6543506	12/2002	Phillips	N/A	N/A
6575218	12/2002	Burns et al.	N/A	N/A
6596224	12/2002	Sachs et al.	N/A	N/A
6641897	12/2002	Gervasi	N/A	N/A
6649113	12/2002	Manners et al.	N/A	N/A
6660209	12/2002	Leyden et al.	N/A	N/A
6668892	12/2002	Vasilakes et al.	N/A	N/A
6682598	12/2003	Steinmueller et al.	N/A	N/A
6780368	12/2003	Liu et al.	N/A	N/A
6786711	12/2003	Koch et al.	N/A	N/A
6838035	12/2004	Ederer et al.	N/A	N/A
6850334	12/2004	Gothait	N/A	N/A
6852272	12/2004	Artz et al.	N/A	N/A
6896839	12/2004	Kubo et al.	N/A	N/A
6914406	12/2004	Wilkes et al.	N/A	N/A
6930144	12/2004	Oriakhi	N/A	N/A
6947058	12/2004	Elmquist	N/A	N/A
6966960	12/2004	Boyd et al.	N/A	N/A
6974521	12/2004	Schermer	N/A	N/A
6986654	12/2005	Imiolek et al.	N/A	N/A
7008209	12/2005	Iskra et al.	N/A	N/A
7016738	12/2005	Karunasiri	N/A	N/A
7022207	12/2005	Hirsch	N/A	N/A
7045738	12/2005	Kovacevic et al.	N/A	N/A
7052263	12/2005	John	N/A	N/A
7070250	12/2005	Lester et al.	N/A	N/A
7074029	12/2005	Stockwell et al.	N/A	N/A
7084875	12/2005	Plante	N/A	N/A
7087109	12/2005	Bredr et al.	N/A	N/A
7158849	12/2006	Huang et al.	N/A	N/A
7164420	12/2006	Ard	N/A	N/A
7195472	12/2006	John	N/A	N/A
7261542	12/2006	Hickerson et al.	N/A	N/A
7270528	12/2006	Sherwood	N/A	N/A
7300613	12/2006	Sano et al.	N/A	N/A
7351304	12/2007	Liang et al.	N/A	N/A
7402219	12/2007	Graf	N/A	N/A

7438846	12/2007	John	N/A	N/A
7455804	12/2007	Patel et al.	N/A	N/A
7520740	12/2008	Wahlstrom et al.	N/A	N/A
7550518	12/2008	Bredt et al.	N/A	N/A
7555726	12/2008	Kurtenbach et al.	N/A	N/A
7569174	12/2008	Ruatta et al.	N/A	N/A
7572403	12/2008	Gu et al.	N/A	N/A
7575682	12/2008	Olsta et al.	N/A	N/A
7578958	12/2008	Patel et al.	N/A	N/A
7614866	12/2008	Sperry et al.	N/A	N/A
7614886	12/2008	Sperry et al.	N/A	N/A
7636610	12/2008	Schillen et al.	N/A	N/A
7698947	12/2009	Sarr	N/A	N/A
7706910	12/2009	Hull et al.	N/A	N/A
7742060	12/2009	Maillot	N/A	N/A
7758799	12/2009	Hull et al.	N/A	N/A
7767132	12/2009	Patel et al.	N/A	N/A
7771183	12/2009	Hull et al.	N/A	N/A
7780429	12/2009	Kikuchi	N/A	N/A
7783371	12/2009	John et al.	N/A	N/A
7785093	12/2009	Holmboe et al.	N/A	N/A
7790093	12/2009	Shkolnik et al.	N/A	N/A
7795349	12/2009	Bredt et al.	N/A	N/A
7815826	12/2009	Serdy et al.	N/A	N/A
7845930	12/2009	Shkolnik et al.	N/A	N/A
7867302	12/2010	Nevoret et al.	N/A	N/A
7892474	12/2010	Shkolnik et al.	N/A	N/A
7894921	12/2010	John et al.	N/A	N/A
7931460	12/2010	Scott et al.	N/A	N/A
7962238	12/2010	Shkolnik et al.	N/A	N/A
7964047	12/2010	Ishida	N/A	N/A
7995073	12/2010	Shemanarev et al.	N/A	N/A
8003040	12/2010	El-Siblani	N/A	N/A
8029642	12/2010	Hagman	N/A	N/A
8048261	12/2010	McCowin	N/A	N/A
8070473	12/2010	Kozlak	N/A	N/A
8071055	12/2010	Newcombe	N/A	N/A
8096262	12/2011	Ederer et al.	N/A	N/A
8105066	12/2011	Sperry et al.	N/A	N/A
8110135	12/2011	El-Siblani	N/A	N/A
8126580	12/2011	El-Siblani et al.	N/A	N/A
8157908	12/2011	Williams	N/A	N/A
8185229	12/2011	Davidson	N/A	N/A
8191500	12/2011	Dohring et al.	N/A	N/A
8211226	12/2011	Bredt et al.	N/A	N/A
8232444	12/2011	Bar Nathan et al.	N/A	N/A
8259103	12/2011	Glueck et al.	N/A	N/A
8269767	12/2011	Glueck et al.	N/A	N/A
8282866	12/2011	Hiraide	N/A	N/A
8326024	12/2011	Shkolnik	N/A	N/A
8372330	12/2012	El-Siblani et al. El-Siblani et al.	N/A	N/A
8394313	12/2012	Ei-Sividili et al.	N/A	N/A

8413578	12/2012	Doyle	N/A	N/A
8424580	12/2012	Anderson et al.	N/A	N/A
8444903	12/2012	Lyons et al.	N/A	N/A
8454879	12/2012	Kuzusako et al.	N/A	N/A
8475946	12/2012	Dion et al.	N/A	N/A
8506862	12/2012	Giller et al.	N/A	N/A
8506870	12/2012	Hochsmann et al.	N/A	N/A
8513562	12/2012	Bichsel	N/A	N/A
8522159	12/2012	Kurtenbach et al.	N/A	N/A
8540501	12/2012	Yasukochi	N/A	N/A
8568646	12/2012	Wang et al.	N/A	N/A
8568649	12/2012	Balistreri et al.	N/A	N/A
8593083	12/2012	Firhoj et al.	N/A	N/A
8616872	12/2012	Matsui et al.	N/A	N/A
8623264	12/2013	Rohner et al.	N/A	N/A
8636494	12/2013	Gothait et al.	N/A	N/A
8636496	12/2013	Das et al.	N/A	N/A
8658076	12/2013	El-Siblani	N/A	N/A
8663568	12/2013	Bar Nathan et al.	N/A	N/A
8666142	12/2013	Shkolnik et al.	N/A	N/A
8703037	12/2013	Hull et al.	N/A	N/A
8715832	12/2013	Ederer et al.	N/A	N/A
8718522	12/2013	Chillscyzn et al.	N/A	N/A
8737862	12/2013	Manico et al.	N/A	N/A
8741194	12/2013	Ederer et al.	N/A	N/A
8741203	12/2013	Liska et al.	N/A	N/A
8744184	12/2013	Ameline et al.	N/A	N/A
8761918	12/2013	Silverbrook	N/A	N/A
8801418	12/2013	El-Siblani et al.	N/A	N/A
8805064	12/2013	Ameline et al.	N/A	N/A
8815143	12/2013	John et al.	N/A	N/A
8844133	12/2013	Fuller	N/A	N/A
8845316	12/2013	Schillen et al.	N/A	N/A
8845953	12/2013	Balistreri et al.	N/A	N/A
8862260	12/2013	Shkolnik et al.	N/A	N/A
8872024	12/2013	Jamar et al.	N/A	N/A
8873024	12/2013	Jamar et al.	N/A	N/A
8876513	12/2013	Lim et al.	N/A	N/A
8877115	12/2013	Elsey	N/A	N/A
8888480	12/2013	Yoo et al.	N/A	N/A
8905739	12/2013	Vermeer et al.	N/A	N/A
8915728	12/2013	Mironets et al.	N/A	N/A
8926304	12/2014	Chen	N/A	N/A
8932511	12/2014	Napendensky	N/A	N/A
8934994	12/2014	Lee	706/14	G05B 19/4099
8968625	12/2014	Tan	N/A	N/A
8974717	12/2014	Maguire et al.	N/A	N/A
8991211	12/2014	Arlotti et al.	N/A	N/A
8992816	12/2014	Jonasson et al.	N/A	N/A
8998601	12/2014	Busato	N/A	N/A
9011982	12/2014	Muller et al.	N/A	N/A
9031680	12/2014	Napadensky	N/A	N/A

9064922 12/2014 Nakajima et al. N/A N/A 9067359 12/2014 Rohner et al. N/A N/A 9067360 12/2014 Rohner et al. N/A N/A 9067361 12/2014 El-Siblani N/A N/A 9079357 12/2014 El-Siblani et al. N/A N/A 9079357 12/2014 Elbert et al. N/A N/A 9101321 12/2014 Huang et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9153052 12/2014 Andersen N/A N/A 9153052 12/2014 DeSimone et al. N/A N/A 9186847 12/2014 DeSimone	9063376	12/2014	Mizumura	N/A	N/A
9067359 12/2014 Rohner et al. N/A N/A 9067360 12/2014 El-Siblani et al. N/A N/A 9067361 12/2014 El-Siblani et al. N/A N/A 9073260 12/2014 El-Siblani et al. N/A N/A 9079357 12/2014 Ebert et al. N/A N/A 9079357 12/2014 Ebert et al. N/A N/A 9101321 12/2014 Kiesser N/A N/A N/A 9140321 12/2014 Huang et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9150032 12/2014 Ameline et al. N/A N/A 9150052 12/2014 Ameline et al. N/A N/A 9150155 12/2014 Ameline et al. N/A N/A 9150155 12/2014 Pruth et al. N/A N/A 9193112 12/2014 Dolkusa et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Douglas et al. N/A N/A 93308690 12/2015 Chen N/A N/A 93360890 12/2015 Boyer et al. N/A N/A 93364218 12/2015 Webb et al. N/A N/A 9346218 12/2015 Douglas et al. N/A N/A 9346218 12/2015 Douglas et al. N/A N/A 9346218 12/2015 Douglas et al. N/A N/A 9346218 12/2015 Ebersimone et al. N/A N/A 9346218 12/2015 Douglas et al. N/A N/A 9346218 12/2015 Ebersimone et al. N/A N/A 9346218 12/2015 Ebersimone et al. N/A N/A 9346218 12/2015 Douglas et al. N/A N/A 9346218 12/2015 Ebersimone et al. N/A N/A 94634218 12/2015 Ebersimone et al. N/A N/A 94634218 12/2015 Douglas et al. N/A N/A N/A 94634218 12/2015 Ebersimone et al. N/A N/A N/A 94634218 12/2015 Ederer et al. N/A N/A N/A 9403322 12/2015 Douglas et al. N/A N/A N/A 9403324 12/2015 Ederer et al. N/A N/A N/A 9463488 12/2015 Ederer et al. N/A N/A N/A 946994 12/2015 Ederer et al. N/A N/A N/A 946994 12/2015 Ederer et al. N/A N/A N/A 946994 12/2015 Ederer et al. N/A N/A N/					
9067360 12/2014 Wehning et al. N/A N/A 9067361 12/2014 El-Siblani N/A N/A 9073360 12/2014 El-Siblani et al. N/A N/A 9079357 12/2014 Ebert et al. N/A N/A 9101321 12/2014 Kfesser N/A N/A 9149986 12/2014 Huang et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9150032 12/2014 Ameline et al. N/A N/A 9150352 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Ameline et al. N/A N/A 9186847 12/2014 Pruth et al. N/A N/A 9186847 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9241664 12/2014 DeSimone et al. N/A N/A 9248600 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 93369360 12/2015 Goodman et al. N/A N/A 9346217 12/2015 Webb et al. N/A N/A 9346217 12/2015 DeSimone et al. N/A N/A 9346217 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 94434107 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A N/A 9403344 12/2015 DeSimone et al. N/A N/A N/A 9403344 12/2015 DeSimone					
9067361 12/2014 El-Siblani N/A N/A 9073260 12/2014 El-Siblani et al. N/A N/A 9073261 12/2014 Ebert et al. N/A N/A 9101321 12/2014 Kiesser N/A N/A 9101321 12/2014 Huang et al. N/A N/A 9150032 12/2014 Huang et al. N/A N/A 9150032 12/2014 Ameline et al. N/A N/A 9150052 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Ameline et al. N/A N/A 9180887 12/2014 Fruth et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 921100 12/2014 DeSimone et al. N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9233304 12/2015 Douglas et al. N/A N/A 923880 12/2015 Goodman et al. N/A N/A 9308690 12/2015 Goodman et al. N/A N/A 9337385 12/2015 Webb et al. N/A N/A 9346218 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A 9403444 12/2015 DeSimone et al. N/A N/A N/A 9403444 12/2015 DeSimone et al. N/A N/A N/A 9457374 12/2015 DeSimone et al. N/A N/A N/A 9457374 12/2015 DeSimone et al. N/A N/A N/A 9459344 12/2015 DeSimone et al. N/A N/A N/A 9486944 12/2015 DeSimone					
9073260 12/2014 El-Siblani et al. N/A N/A 9079357 12/2014 Ebert et al. N/A N/A N/A 9101321 12/2014 Kiesser N/A N/A 9149986 12/2014 Huang et al. N/A N/A 9149986 12/2014 Houng et al. N/A N/A 9153052 12/2014 Andersen N/A N/A N/A 9153052 12/2014 Andersen N/A N/A N/A 9153052 12/2014 Andersen N/A N/A N/A 9153155 12/2014 Pruth et al. N/A N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A N/A 9233504 12/2015 Douglas et al. N/A N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 936690 12/2015 Goodman et al. N/A N/A 936690 12/2015 Goodman et al. N/A N/A N/A 9346218 12/2015 Huang et al. N/A N/A N/A 9346217 12/2015 Douglas et al. N/A N/A N/A 9346217 12/2015 Douglas et al. N/A N/A N/A 9346218 12/2015 Goodman et al. N/A N/A N/A 936888 12/2015 Goodman et al. N/A N/A N/A 936888 12/2015 Goodman et al. N/A N/A N/A 936888 12/2015 Goodman et al. N/A N/A N/A 9346218 12/2015 Goodman et al. N/A N/A N/A 936888 12/2015 Goodman et al. N/A N/A N/A 9403324 12/2015 Goodman et al. N/A N/A N/A 9405444 12/2015 Goodman et al. N/A N/A N/A 9415547 12/2015 Goodman et al. N/A N/A N/A 9435407 12/2015 Goodman et al. N/A N/A N/A 943644 12/2015 Goodman et al. N/A N/A N/A 945634 12/2015 Goodman et al. N/A N/A N/A 945634 12/2015 Goodman et al. N/A N/A N/A 946904 12/2015 Goodman et al. N/A N/A N/A 946904 12/2015 Goodman et al. N/A N/A N/A 948694 12/2015 Goodman et al. N/A N/A N/A 948990 12/2015 Goodman et al. N/A N/A N/A 948990 12/2015 Goodman et al. N/A N/A N/A 948990 12	9067361		_	N/A	N/A
9079357 12/2014 Ebert et al. N/A N/A 9101321 12/2014 Kiesser N/A N/A N/A 9149986 12/2014 Huang et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9150155 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Fruth et al. N/A N/A 9186847 12/2014 Pruth et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211608 12/2014 DeSimone et al. N/A N/A 9231504 12/2015 Douglas et al. N/A N/A N/A 92348600 12/2015 Goodman et al. N/A N/A 9308690 12/2015 Goodman et al. N/A N/A 9308690 12/2015 Boyer et al. N/A N/A N/A 9308690 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Desimone et al. N/A N/A 9403324 12/2015 Desimone et al. N/A N/A 9403324 12/2015 Desimone et al. N/A N/A 9415544 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415544 12/2015 Fuller N/A N/A 9436884 12/2015 Ederer et al. N/A N/A 9436488 12/2015 Ederer et al. N/A N/A 9436488 12/2015 Ederer et al. N/A N/A 9436444 12/2015 Fuller N/A N/A 9436444 12/2015 Ederer et al. N/A N/A 9436407 12/2015 Ederer et al. N/A N/A 9436407 12/2015 Ederer et al. N/A N/A 9436444 12/2015 Ederer et al. N/A N/A N/A 9436407 12/2015 Ederer et al. N/A N/A N/A 9453142 12/2015 Ederer et al. N/A N/A N/A 9450444 12/2015 Ederer et al. N/A N/A N/A 946944 12/201			El-Siblani et al.		
9101321 12/2014 Kiesser N/A N/A 9149986 12/2014 Huang et al. N/A N/A 9150032 12/2014 Roof et al. N/A N/A 9150032 12/2014 Ameline et al. N/A N/A 9150155 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Fruth et al. N/A N/A 9199112 12/2014 Pruth et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A N/A 9233504 12/2015 Douglas et al. N/A N/A N/A 9233504 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Goodman et al. N/A N/A 936690 12/2015 Goodman et al. N/A N/A 9346217 12/2015 Webb et al. N/A N/A N/A 9346217 12/2015 Webb et al. N/A N/A N/A 9346218 12/2015 Chen et al. N/A N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A N/A 9415544 12/2015 Goodman et al. N/A N/A N/A 9415547 12/2015 DeSimone et al. N/A N/A N/A 9415547 12/2015 DeSimone et al. N/A N/A N/A 9415547 12/2015 DeSimone et al. N/A N/A N/A 941543 12/2015 Chen et al. N/A N/A N/A 9415443 12/2015 Chen et al. N/A N/A N/A 9429104 12/2015 Ederer et al. N/A N/A N/A 943604 12/2015 Fuller N/A N/A N/A 943604 12/2015 Rolland et al. N/A N/A N/A 9456884 12/2015 Goodman et al. N/A N/A N/A 9456884 12/2015 DeSimone et al. N/A N/A N/A 9456884 12/2015 DeSimone et al. N/A N/A N/A 9456884 12/2015 DeSimone et al. N/A N/A N/A 9456684 12/2015 Goodman et al. N/A N/A N/A 9469074 12/2015 Goodman et al. N/A N/A N/A 9469074 12/2015 Goodman et al. N/A N/A N/A 9469074 12/2015 Goodman et al. N/A N/A N/A 9469920 12/2015 G					
9149986 12/2014 Huang et al. N/A N/A 9153052 12/2014 Roof et al. N/A N/A N/A 9153052 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Andersen N/A N/A N/A 9196847 12/2014 Pruth et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 92116546 12/2014 DeSimone et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9368600 12/2015 Goodman et al. N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A 94034218 12/2015 DeSimone et al. N/A N/A 94034218 12/2015 DeSimone et al. N/A N/A 9403441 12/2015 DeSimone et al. N/A N/A N/A 9403421 12/2015 DeSimone et al. N/A N/A N/A 940344 12/2015 DeSimone et al. N/A N/A N/A 940344 12/2015 DeSimone et al. N/A N/A N/A 9415547 12/2015 DeSeimone et al. N/A N/A N/A 9429104 12/2015 Rolland et al. N/A N/A N/A 9434107 12/2015 Rolland et al. N/A N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A N/A 9456884 12/2015 Hibbs et al. N/A N/A N/A 9469074 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 DeSimone et al. N/A N/A N/A 946944 12/2015 DeSimone et al. N/A N/A N/A 9486944 12/2015 DeSimone et al. N/A N/A N/A 9456884 12/2015 DeSimone et al. N/A N/A N/A 9456944 12/2015 DeSimone et al. N/A N/A N/A 9456944 12/2015 DeSimone et al	9101321	12/2014	Kiesser	N/A	N/A
9150032 12/2014 Roof et al. N/A N/A 9153052 12/2014 Ameline et al. N/A N/A 9159155 12/2014 Ameline et al. N/A N/A 9186847 12/2014 Fruth et al. N/A N/A 9193112 12/2014 DeSimone et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 921678 12/2014 DeSimone et al. N/A N/A 921678 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 921100 12/2014 DeSimone et al. N/A N/A 923504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Goodman et al. N/A N/A 9308690 12/2015 Goodman et al. N/A N/A 9327385 12/2015 Boyer et al. N/A N/A 9346217 12/2015 Boyer et al. N/A N/A 9346217 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403324 12/2015 DeSimone et al. N/A N/A 9403324 12/2015 Das et al. N/A N/A 9403324 12/2015 Das et al. N/A N/A 941544 12/2015 Ederer et al. N/A N/A 941544 12/2015 Ghen et al. N/A N/A 9436884 12/2015 Chen et al. N/A N/A N/A 9436484 12/2015 Ederer et al. N/A N/A 943644 12/2015 Ederer et al. N/A N/A 943644 12/2015 Chen et al. N/A N/A N/A 943644 12/2015 Ederer et al. N/A N/A 9434107 12/2015 Chen et al. N/A N/A N/A 9434107 12/2015 Ederer et al. N/A N/A 9434107 12/2015 Ederer et al. N/A N/A N/A 9453142 12/2015 Ederer et al. N/A N/A 946984 12/2015 Ederer et al. N/A N/A 946984 12/2015 Ederer et al. N/A N/A 9469974 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9487374 12/2015 Ederer et al. N/A N/A 9469974 12/2015 Ederer et al. N/A N/A 9469974 12/2015 Ederer et al. N/A N/A 9469974 12/2015 Ederer et al. N/A N/A 9487374 12/2015 Ederer et al. N/A N/A 9487374 12/2015 Ederer et al. N/A N/A 9487443 12/2015 Ederer et al. N/A N/A 9487444 12/2015 Ederer et al. N/A N/A 94875991 12/2015 Ederer et al. N/A N/A N/A 9488991 12/20	9149986		Huang et al.	N/A	N/A
9159155 12/2014 Andersen N/A N/A 9186847 12/2014 Fruth et al. N/A N/A 9193112 12/2014 Ohkusa et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 936690 12/2015 Goodman et al. N/A N/A 9327385 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9436107 12/2015 Chen et al. N/A N/A 9436107 12/2015 Ederer et al. N/A N/A 943107 12/2015 Chen et al. N/A N/A 9436848 12/2015 Ederer et al. N/A N/A 943604 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A N/A 945684 12/2015 Ederer et al. N/A N/A N/A 946684 12/2015 Ederer et al. N/A N/A N/A 946684 12/2015 Ederer et al. N/A N/A N/A 9469074 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 948744 12/2015 Ederer et al. N/A N/A N/A 948744 12/2015 Ederer et	9150032		9	N/A	N/A
9159155 12/2014 Andersen N/A N/A 9186847 12/2014 Fruth et al. N/A N/A 9193112 12/2014 Ohkusa et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 936690 12/2015 Goodman et al. N/A N/A 9327385 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9436107 12/2015 Chen et al. N/A N/A 9436107 12/2015 Ederer et al. N/A N/A 943107 12/2015 Chen et al. N/A N/A 9436848 12/2015 Ederer et al. N/A N/A 943604 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A 943684 12/2015 Ederer et al. N/A N/A N/A 945684 12/2015 Ederer et al. N/A N/A N/A 946684 12/2015 Ederer et al. N/A N/A N/A 946684 12/2015 Ederer et al. N/A N/A N/A 9469074 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 948744 12/2015 Ederer et al. N/A N/A N/A 948744 12/2015 Ederer et			Ameline et al.		
9193112 12/2014 Ohkusa et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9221100 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9346217 12/2015 Webb et al. N/A N/A 9346218 12/2015 Huang et al. N/A N/A 9366757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9415443 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9429104 12/2015 Chen et al. N/A N/A 9436884 12/2015 Das et al. N/A N/A 9437324 12/2015 Das et al. N/A N/A N/A 9415544 12/2015 Chen et al. N/A N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 94374107 12/2015 Chen et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Edere et al. N/A N/A 9436684 12/2015 Edere et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9457374 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 94669074 12/2015 Ederer et al. N/A N/A 94669074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 DeSimone et al. N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 9487444 12/2015 DeSimone et al. N/A N/A 948744	9159155	12/2014		N/A	N/A
9193112 12/2014 Ohkusa et al. N/A N/A 9205601 12/2014 DeSimone et al. N/A N/A 9211678 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9221100 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9346217 12/2015 Webb et al. N/A N/A 9346218 12/2015 Huang et al. N/A N/A 9366757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9415443 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9429104 12/2015 Chen et al. N/A N/A 9436884 12/2015 Das et al. N/A N/A 9437324 12/2015 Das et al. N/A N/A N/A 9415544 12/2015 Chen et al. N/A N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 94374107 12/2015 Chen et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Edere et al. N/A N/A 9436684 12/2015 Edere et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9457374 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 9466884 12/2015 Ederer et al. N/A N/A 94669074 12/2015 Ederer et al. N/A N/A 94669074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 DeSimone et al. N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 9487444 12/2015 DeSimone et al. N/A N/A 948744	9186847		Fruth et al.	N/A	N/A
9211678 12/2014 DeSimone et al. N/A N/A 9216546 12/2014 DeSimone et al. N/A N/A 921100 12/2014 Schwarze et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9233504 12/2015 Goodman et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 Chen et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 Das et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9415544 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9415547 12/2015 Das et al. N/A N/A 9436488 12/2015 Ederer et al. N/A N/A 9431544 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Ederer et al. N/A N/A 9436684 12/2015 Chen et al. N/A N/A 9436694 12/2015 Ederer et al. N/A N/A 94366884 12/2015 Ederer et al. N/A N/A 9446557 12/2015 Ederer et al. N/A N/A 9446694 12/2015 Ederer et al. N/A N/A 94466884 12/2015 Ederer et al. N/A N/A 9453142 12/2015 Ederer et al. N/A N/A 9456884 12/2015 Ederer et al. N/A N/A 946944 12/2015 Ederer et al. N/A N/A 946944 12/2015 Ederer et al. N/A N/A 9486944 12	9193112	12/2014	Ohkusa et al.	N/A	
9216546 12/2014 DeSimone et al. N/A N/A 9221100 12/2014 Schwarze et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9233504 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9415443 12/2015 Ederer et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9415547 12/2015 Ederer et al. N/A N/A 943324 12/2015 Ederer et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A N/A 9415547 12/2015 Ederer et al. N/A N/A 9436077 12/2015 Chen et al. N/A N/A N/A 94384107 12/2015 Fuller N/A N/A N/A 9434107 12/2015 Zenere N/A N/A N/A 9453142 12/2015 Zenere N/A N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Ederer et al. N/A N/A 9456884 12/2015 Ederer et al. N/A N/A N/A 9456884 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 9458940 12/2015 Ederer et al. N/A N/A N/A 945734 12/2015 Ederer et al. N/A N/A N/A 945948920 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Edere	9205601	12/2014	DeSimone et al.	N/A	N/A
9221100 12/2014 Schwarze et al. N/A N/A 9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 946848 12/2015 Das et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9415443 12/2015 Ederer et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9429104 12/2015 Chen et al. N/A N/A 943312 12/2015 Chen et al. N/A N/A N/A 9415547 12/2015 Ederer et al. N/A N/A N/A 9429104 12/2015 Chen et al. N/A N/A N/A 9438684 12/2015 Chen et al. N/A N/A N/A 9434107 12/2015 Chen et al. N/A N/A N/A 9434107 12/2015 Zenere N/A N/A N/A 9453142 12/2015 Zenere et al. N/A N/A N/A 9453142 12/2015 Ederer et al. N/A N/A N/A 945348 12/2015 Uckelmann et al. N/A N/A N/A 945348 12/2015 Ederer et al. N/A N/A N/A 945348 12/2015 Ederer et al. N/A N/A N/A 9450684 12/2015 Ederer et al. N/A N/A N/A 9469074 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Ederer et al. N/A N/A N/A 948694 12/2015 Ederer et al. N/A N/A N/A 948694 12/2015 Ederer et al. N/A N/A N/A 948694 12/2015 DeSimone et al. N/A N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A N/A 948920 12/2015 DeSimone et al. N/A N/A N/A 948920 12/2015 DeSimone et al. N/A N/A N/A 9517591 12/2015 Yoo et al. N/A N/A N/A 9517591 12/2015 Felebe N/A N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A	9211678	12/2014	DeSimone et al.	N/A	N/A
9233504 12/2015 Douglas et al. N/A N/A 9248600 12/2015 Goodman et al. N/A N/A N/A 9259880 12/2015 Chen N/A N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A N/A 9346217 12/2015 Huang et al. N/A N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A N/A 9364848 12/2015 Silverbrook N/A N/A N/A 9403322 12/2015 Das et al. N/A N/A N/A 9415443 12/2015 Ederer et al. N/A N/A N/A 9415544 12/2015 Chen et al. N/A N/A N/A 9415547 12/2015 Chen et al. N/A N/A N/A 9429104 12/2015 Chen et al. N/A N/A N/A 9433142 12/2015 Chen et al. N/A N/A N/A 9433142 12/2015 Ederer et al. N/A N/A N/A 9436884 12/2015 Ederer et al. N/A N/A N/A 9436844 12/2015 Euller N/A N/A N/A 9453142 12/2015 Ederer et al. N/A N/A N/A 9453142 12/2015 Ederer et al. N/A N/A N/A 945884 12/2015 Ederer et al. N/A N/A N/A 945884 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 9469074 12/2015 Ederer et al. N/A N/A N/A 9486944 12/2015 Ederer et al. N/A N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A N/A 948920 12/2015 DeSimone et al. N/A N/A N/A 948920 12/2015 DeSimone et al. N/A N/A N/A 9498921 12/2015 Teulet N/A N/A N/A 9517591 12/2015 Yoo et al. N/A N/A N/A 9517591 12/2015 El-Siblani N/A N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A	9216546	12/2014	DeSimone et al.	N/A	N/A
9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A N/A 9308690 12/2015 Boyer et al. N/A N/A N/A 9327385 12/2015 Webb et al. N/A N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 Chen et al. N/A N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A N/A 9364848 12/2015 DeSimone et al. N/A N/A N/A 9403322 12/2015 Das et al. N/A N/A N/A 9403324 12/2015 Ederer et al. N/A N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A N/A 9415544 12/2015 Chen et al. N/A N/A N/A 9429104 12/2015 Fuller N/A N/A N/A 9433142 12/2015 Zenere N/A N/A N/A 9435142 12/2015 Zenere et al. N/A N/A N/A 9436884 12/2015 Zenere et al. N/A N/A N/A 9457374 12/2015 Rolland et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 9457374 12/2015 Workenson et al. N/A N/A N/A 9457374 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 946944 12/2015 Ederer et al. N/A N/A N/A 9487443 12/2015 Ederer et al. N/A N/A N/A 9487443 12/2015 Ederer et al. N/A N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 948990 12/2015 DeSimone et al. N/A N/A 948991 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Chen et al. N/A N/A N/A 9498921 12/2015 PoSimone et al. N/A N/A 9498921 12/2015 PoSimone et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A	9221100	12/2014	Schwarze et al.	N/A	N/A
9248600 12/2015 Goodman et al. N/A N/A 9259880 12/2015 Chen N/A N/A 9308690 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Ederer et al. N/A N/A 9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415544 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9445547 12/2015 Zenere N/A N/A 9446557 12/2015 Rolland<	9233504	12/2015	Douglas et al.	N/A	N/A
9308690 12/2015 Boyer et al. N/A N/A 9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 Chen et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 Das et al. N/A N/A 9403322 12/2015 Ederer et al. N/A N/A 9403324 12/2015 Ljungblad et al. N/A N/A 9415443 12/2015 Kerekes et al. N/A N/A 9415544 12/2015 Chen et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Rolland et al. N/A N/A 9453142 12/2015 Uckel	9248600	12/2015	_	N/A	N/A
9327385 12/2015 Webb et al. N/A N/A 9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 Chen et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 Silverbrook N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Ederer et al. N/A N/A N/A 9415443 12/2015 Kerekes et al. N/A N/A 9415544 12/2015 Chen et al. N/A N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 944557 12/2015 Zenere N/A N/A 9453142 12/2015 Zenere et al. N/A N/A 9456884 12/2015 Rolland et al. N/A N/A 9457374 12/2015 Uckelmann et al. N/A N/A 946684 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9487443 12/2015 Doscimone et al. N/A N/A 9487443 12/2015 Doscimone et al. N/A N/A 9488920 12/2015 Doscimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A N/A 9498921 12/2015 Teulet N/A N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A 9529371 12/2015 Nakamura N/A N/A	9259880	12/2015	Chen	N/A	N/A
9346217 12/2015 Huang et al. N/A N/A 9346218 12/2015 Chen et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9364848 12/2015 Silverbrook N/A N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Ederer et al. N/A N/A 9415443 12/2015 Kerekes et al. N/A N/A 9415544 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 944557 12/2015 Zenere N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 945884 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Hibbs et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A 9529371 12/2015 Nakamura N/A N/A	9308690	12/2015	Boyer et al.	N/A	N/A
9346218	9327385	12/2015	<u>-</u>	N/A	N/A
9346218 12/2015 Chen et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A 9360757 12/2015 DeSimone et al. N/A N/A N/A 9364848 12/2015 Silverbrook N/A N/A N/A 9403322 12/2015 Das et al. N/A N/A N/A 9403324 12/2015 Ederer et al. N/A N/A N/A 9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A N/A 9429104 12/2015 Chen et al. N/A N/A N/A 9434107 12/2015 Zenere N/A N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9469488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 EJ-Siblani et al. N/A N/A 9487443 12/2015 DoSimone et al. N/A N/A 948920 12/2015 DeSimone et al. N/A N/A 948921 12/2015 Teulet N/A N/A 948921 12/2015 Teulet N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A	9346217	12/2015	Huang et al.	N/A	N/A
9364848 12/2015 Silverbrook N/A N/A 9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Ederer et al. N/A N/A 9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A N/A 9434107 12/2015 Zenere N/A N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Ederer et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 946904 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Doyce N/A N/A 948743 12/2015 Watanabe N/A N/A 948920 12/2015 DeSimone et al. N/A N/A 948920 12/2015 Chen et al. N/A N/A 9498921 12/2015 Chen et al. N/A N/A 9498921 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A N/A 9529371 12/2015 Steele N/A N/A	9346218	12/2015	_	N/A	N/A
9403322 12/2015 Das et al. N/A N/A 9403324 12/2015 Ederer et al. N/A N/A 9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Ederer et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Ederer et al. N/A N/A 9486964 12/2015 Watanabe N/A N/A 9488920 12/2015 D	9360757	12/2015	DeSimone et al.	N/A	N/A
9403324 12/2015 Ederer et al. N/A N/A 9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Ederer et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 94869074 12/2015 El-Siblani et al. N/A N/A 9486964 12/2015 Watanabe N/A N/A 9487443 12/2015 DeSimone et al. N/A N/A 9498920 12/2015	9364848	12/2015	Silverbrook	N/A	N/A
9415443 12/2015 Ljungblad et al. N/A N/A 9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9415547 12/2015 Fuller N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 94869074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 Use N/A N/A 9487433 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al.	9403322	12/2015	Das et al.	N/A	N/A
9415544 12/2015 Kerekes et al. N/A N/A 9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 <t< td=""><td>9403324</td><td>12/2015</td><td>Ederer et al.</td><td>N/A</td><td>N/A</td></t<>	9403324	12/2015	Ederer et al.	N/A	N/A
9415547 12/2015 Chen et al. N/A N/A 9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9527224 12/2015 El	9415443	12/2015	Ljungblad et al.	N/A	N/A
9429104 12/2015 Fuller N/A N/A 9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 El-Siblani et al. N/A N/A 9486944 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 Steele	9415544	12/2015	Kerekes et al.	N/A	N/A
9434107 12/2015 Zenere N/A N/A 9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 El-Siblani et al. N/A N/A 9486944 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9529371 12/2015 Nakamura <td>9415547</td> <td>12/2015</td> <td>Chen et al.</td> <td>N/A</td> <td>N/A</td>	9415547	12/2015	Chen et al.	N/A	N/A
9446557 12/2015 Zenere et al. N/A N/A 9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9487443 12/2015 Joyce N/A N/A 9488920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamu	9429104	12/2015	Fuller	N/A	N/A
9453142 12/2015 Rolland et al. N/A N/A 9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9487443 12/2015 Joyce N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9434107	12/2015	Zenere	N/A	N/A
9456884 12/2015 Uckelmann et al. N/A N/A 9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9486964 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9446557	12/2015	Zenere et al.	N/A	N/A
9457374 12/2015 Hibbs et al. N/A N/A 9463488 12/2015 Ederer et al. N/A N/A 9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9486964 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9453142	12/2015	Rolland et al.	N/A	N/A
946348812/2015Ederer et al.N/AN/A946907412/2015Ederer et al.N/AN/A948694412/2015El-Siblani et al.N/AN/A948696412/2015JoyceN/AN/A948744312/2015WatanabeN/AN/A949892012/2015DeSimone et al.N/AN/A949892112/2015TeuletN/AN/A951154612/2015Chen et al.N/AN/A951759112/2015Yoo et al.N/AN/A951759212/2015Yoo et al.N/AN/A952724412/2015El-SiblaniN/AN/A952727212/2015SteeleN/AN/A952937112/2015NakamuraN/AN/A	9456884	12/2015	Uckelmann et al.	N/A	N/A
9469074 12/2015 Ederer et al. N/A N/A 9486944 12/2015 El-Siblani et al. N/A N/A 9486964 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9457374	12/2015	Hibbs et al.	N/A	N/A
9486944 12/2015 El-Siblani et al. N/A N/A 9486964 12/2015 Joyce N/A N/A 9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9463488	12/2015		N/A	N/A
948696412/2015JoyceN/AN/A948744312/2015WatanabeN/AN/A949892012/2015DeSimone et al.N/AN/A949892112/2015TeuletN/AN/A951154612/2015Chen et al.N/AN/A951759112/2015Yoo et al.N/AN/A951759212/2015Yoo et al.N/AN/A952724412/2015El-SiblaniN/AN/A952727212/2015SteeleN/AN/A952937112/2015NakamuraN/AN/A	9469074	12/2015	Ederer et al.	N/A	N/A
9487443 12/2015 Watanabe N/A N/A 9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9486944	12/2015	El-Siblani et al.	N/A	N/A
9498920 12/2015 DeSimone et al. N/A N/A 9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9486964	12/2015	Joyce	N/A	N/A
9498921 12/2015 Teulet N/A N/A 9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9487443	12/2015	Watanabe	N/A	N/A
9511546 12/2015 Chen et al. N/A N/A 9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9498920	12/2015	DeSimone et al.		
9517591 12/2015 Yoo et al. N/A N/A 9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A					
9517592 12/2015 Yoo et al. N/A N/A 9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9511546	12/2015	Chen et al.	N/A	N/A
9527244 12/2015 El-Siblani N/A N/A 9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A	9517591	12/2015	Yoo et al.	N/A	N/A
9527272 12/2015 Steele N/A N/A 9529371 12/2015 Nakamura N/A N/A					
9529371 12/2015 Nakamura N/A N/A					
9533450 12/2016 El-Siblani et al. N/A N/A					
	9533450	12/2016	El-Siblani et al.	N/A	N/A

9539762	12/2016	Durand et al.	N/A	N/A
9545753	12/2016	Costabeber	N/A	N/A
9545784	12/2016	Nakamura	N/A	N/A
9550326	12/2016	Costabeber	N/A	N/A
9561622	12/2016	Das et al.	N/A	N/A
9561623	12/2016	El-Siblani et al.	N/A	N/A
9578695	12/2016	Jerby et al.	N/A	N/A
9579852	12/2016	Okamoto	N/A	N/A
9581530	12/2016	Guthrie et al.	N/A	N/A
9592635	12/2016	Ebert et al.	N/A	N/A
9604411	12/2016	Rogren	N/A	N/A
9610616	12/2016	Chen et al.	N/A	N/A
9616620	12/2016	Hoechsmann et al.	N/A	N/A
9632037	12/2016	Chen et al.	N/A	N/A
9632420	12/2016	Allanic	N/A	N/A
9632983	12/2016	Ueda et al.	N/A	N/A
9636873	12/2016	Joyce	N/A	N/A
9649812	12/2016	Hartmann et al.	N/A	N/A
9649815	12/2016	Atwood et al.	N/A	N/A
9656344	12/2016	Kironn et al.	N/A	N/A
9670371	12/2016	Pervan et al.	N/A	N/A
9676143	12/2016	Kashani-Shirazi	N/A	N/A
9676963	12/2016	Rolland et al.	N/A	N/A
9682166	12/2016	Watanabe	N/A	N/A
9682425	12/2016	Xu et al.	N/A	N/A
9688027	12/2016	Batchelder et al.	N/A	N/A
9707720	12/2016	Chen et al.	N/A	N/A
9720363	12/2016	Chillscyzn et al.	N/A	N/A
9738034	12/2016	Gruber et al.	N/A	N/A
9738564	12/2016	Capobianco et al.	N/A	N/A
9751292	12/2016	Jamar et al.	N/A	N/A
9764513	12/2016	Stampfl et al.	N/A	N/A
9764535	12/2016	Xie et al.	N/A	N/A
9821546	12/2016	Schaafsma et al.	N/A	N/A
9862146	12/2017	Driessen et al.	N/A	N/A
9862150	12/2017	Chen et al.	N/A	N/A
9868255	12/2017	Comb et al.	N/A	N/A
9885987	12/2017	Chillscysn et al.	N/A	N/A
9895843	12/2017	Lobovsky et al.	N/A	N/A
9901983	12/2017	Hovel et al.	N/A	N/A
9908293	12/2017	Yoo et al.	N/A	N/A
9919474	12/2017	Napadensky	N/A	N/A
9919515	12/2017	Daniell et al.	N/A	N/A
9950368	12/2017	Lampenscherf et al.	N/A	N/A
9956727	12/2017	Steele	N/A	N/A
9962767	12/2017	Buller et al.	N/A	N/A
9981411	12/2017	Green et al.	N/A	N/A
10000023	12/2017	El-Siblani et al.	N/A	N/A
10011076	12/2017	El-Siblani et al.	N/A	N/A
10061302	12/2017	Jacobs et al.	N/A	N/A
10071422	12/2017	Buller et al.	N/A	N/A
10124532	12/2017	El-Siblani et al.	N/A	N/A

10155345 12/2017 Ermoshkin et al. N/A N/A 10155882 12/2018 Buller et al. N/A N/A 10183330 12/2018 Buller et al. N/A N/A 10240066 12/2018 Rolland et al. N/A N/A 10240066 12/2018 Rolland et al. N/A N/A 10240066 12/2018 Rolland et al. N/A N/A 1034784 12/2018 de Pena et al. N/A N/A 10317882 12/2018 Das et al. N/A N/A 10336055 12/2018 Das et al. N/A N/A 10350823 12/2018 Moore et al. N/A N/A 10350823 12/2018 Rolland et al. N/A N/A 10350823 12/2018 Usami et al. N/A N/A 10357956 12/2018 Usami et al. N/A N/A 10406748 12/2018 Honda N/A N/A 10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Yuan et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 El-Siblani et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 11141909 12/2020 Dubelman et al. N/A N/A 11141909 12/2020 Dubelman et al. N/A N/A 11524457 12/2001 Dubelman et al. N/A N/A 2003/0102682 12/2002 Sherwood N/A N/A 2003/0102682 12/2002 Sherwood N/A N/A 2003/0102682 12/2002 Sherwood N/A N/A 2005/0016677 12/2004 Nagano et al. N/A N/A 2005/0016677 12/2004 Nakashima N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 1042006/0230984 12/2006 Lazzerini N/A N/A 1042006/0230984 12/2007 Sperry et al. N/A N/A 104007057 12/2004 B	10150254	12/2017	Bauman et al.	N/A	N/A
10155882					
10183330					
10183444					
10240066	10183444	12/2018	Campbell		N/A
10245784 12/2018 Teken et al. N/A N/A 10317882 12/2018 Das et al. N/A N/A 10336055 12/2018 Das et al. N/A N/A 10336055 12/2018 Moore et al. N/A N/A 10350823 12/2018 Rolland et al. N/A N/A 10350823 12/2018 Honda N/A N/A 10406748 12/2018 Honda N/A N/A 10406748 12/2019 Yang et al. N/A N/A 10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Fujita et al. N/A N/A 10639843 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A 2003/0102682 12/2002 Artz et al. N/A N/A 2005/001239 12/2004 Nakashima N/A N/A 2005/001239 12/2004 Nakashima N/A N/A 2005/0016677 12/2004 Nakashima N/A N/A 2005/0016677 12/2004 Nakashima N/A N/A 2005/0016677 12/2004 Nakashima N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Elbes et al. N/A N/A 2006/0230984 12/2006 Lazzerini N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/013800 12/2009 Morohoshi et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2011/00299016 12/2010 El-Siblani et al. N/A		12/2018	-		
10336055 12/2018 Das et al. N/A N/A 10350823 12/2018 Rolland et al. N/A N/A 10350823 12/2018 Usami et al. N/A N/A 10406748 12/2018 Honda N/A N/A 10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Yuan et al. N/A N/A 10682808 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 11141909 12/2020 Dwivedi et al. N/A N/A 11142909 12/2020 Dubelman et al. N/A N/A 111524457 12/2021 Steege N/A N/A 11524457 12/2021 Steege N/A N/A 1030/0102682 12/2002 Kurjpers et al. N/A N/A 1030/0102682 12/2002 Kurokawa N/A N/A 2003/0103662 12/2002 Sherwood N/A N/A 2003/0102683 12/2002 Sherwood N/A N/A 2005/0012239 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012039 12/2004 Nakashima N/A N/A 2005/0012039 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashima N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2011/010570 12/2010 Ducker et al. N/A N/A 2011/0105999 12/2010 Ducker et al. N/A N/A 2011/0105999 12/20				N/A	
10336055 12/2018 Das et al. N/A N/A 10336057 12/2018 Moore et al. N/A N/A N/A 10350823 12/2018 Usami et al. N/A N/A 10350823 12/2018 Usami et al. N/A N/A 10406748 12/2018 Honda N/A N/A 10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Yuan et al. N/A N/A 10682808 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 1141909 12/2020 Dwivedi et al. N/A N/A 111524457 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A 100370102682 12/2002 Kurjpers et al. N/A N/A 100370102682 12/2002 Kurokawa N/A N/A 2003/0103662 12/2002 Artz et al. N/A N/A 2003/01209836 12/2002 Sherwood N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0012039 12/2004 Nakashima N/A N/A 2005/0012039 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashima N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Elbes et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2006 Cunningham et al. N/A N/A 2009/0146344 12/2007 Sperry et al. N/A N/A 2009/0146344 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2009/0146344 12/2009 Sae et al. N/A N/A 2010/0290016 12/2009 Kaehr et al. N/A N/A 2010/0290016 12/2009 Kaehr et al. N/A N/A 2010/0290016 12/2010 El-Siblani et al. N/A N/A 2011/010570 12/2010 Ducker et al. N/A N/A 2011/0105994 12/2011 El-Siblani et al. N/A N/A 2011/0105900 12/2011 El-Siblani et al. N/A N/A	10317882	12/2018	de Pena et al.	N/A	N/A
10357956	10336055	12/2018		N/A	N/A
10357956	10336057	12/2018	Moore et al.	N/A	N/A
10406748 12/2018 Honda N/A N/A 10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Yuan et al. N/A N/A 10682808 12/2019 Hunyu et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Dubelman et al. N/A N/A 11179891 12/2021 Steege N/A N/A 11524457 12/2021 Steege N/A N/A 2003/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0120836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashima N/A N/A 2005/0056677 12/2004 Nakashima N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2006/0248062 12/2006 Cunningham et al. N/A N/A 2008/0179787 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Allaman et al. N/A N/A 2008/0179787 12/2007 Allaman et al. N/A N/A 2008/024352 12/2007 Allaman et al. N/A N/A 2008/024352 12/2007 Allaman et al. N/A N/A 2008/0133800 12/2008 El-Siblani et al. N/A N/A 2010/003619 12/2009 Das et al. N/A N/A 2010/003619 12/2009 Vamazaki et al. N/A N/A 2010/003619 12/2009 Das et al. N/A N/A 2011/005994 12/2001 El-Siblani et al. N/A N/A 2011/0059994 12/2010 Ducker et al. N/A N/A 2011/0059994 12/2011 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/A 2011/0159994 12/2011 El-Siblani et al. N/A N/A 2011/0159994 12/2011 El-Siblani et al. N/A N/A 2011/0159990 12/2011 El-Siblani et al. N/A N/A 2011/0159990 12/2011 El-Siblani et al.	10350823	12/2018	Rolland et al.	N/A	N/A
10612112 12/2019 Yang et al. N/A N/A 10639843 12/2019 Fujita et al. N/A N/A 10682808 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Tujere et al. N/A N/A N/A 11141909 12/2020 Tujere et al. N/A N/A 11524457 12/2021 Steege N/A N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0102682 12/2002 Sherwood N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2003/02239 12/2004 Nakashima N/A N/A 2005/0012239 12/2004 Nakashika et al. N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2007/0063366 12/2005 Elbes et al. N/A N/A 2007/016937 12/2006 Cunningham et al. N/A N/A 2007/016336 12/2006 Cunningham et al. N/A N/A 2008/0214352 12/2007 Sperry et al. N/A N/A 2008/021404 12/2007 Allaman et al. N/A N/A 2008/021404 12/2007 Allaman et al. N/A N/A 2008/021404 12/2007 Allaman et al. N/A N/A 2008/0214380 12/2008 El-Siblani N/A N/A 2010/009361 12/2009 Das et al. N/A N/A 2010/009361 12/2009 Cale et al. N/A N/A 2011/0089610 12/2009 Cale et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0162989 12/2011 El-Siblani et al. N/A N/A 2011/0162989 12/2011 El-Siblani et al. N/A N/A 2012/00952800 12/2011 El-Siblani et al. N/A N/A 2012/00952800 12/2011 El-Siblani et al. N/A N/A 2012/00952800 12/2011 El-Siblani et al. N/A N/A 2012/0052800 12/2011 El-Siblani et al. N/A N/A 2012/0052800 12/2011 El-Siblani et al. N/A N/A 20	10357956	12/2018	Usami et al.	N/A	N/A
10639843 12/2019 Yuan et al. N/A N/A 10682808 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 11141909 12/2020 Dwivedi et al. N/A N/A 11179891 12/2020 Dubelman et al. N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2004/0042789 12/2002 Sherwood N/A N/A 2005/0012239 12/2003 Puffer, Jr. et al. N/A N/A 2005/0019016 12/2004 Nakashima N/A N/A 2005/0023984 12/2005 Bredt et al. N/A N/A <t< td=""><td>10406748</td><td>12/2018</td><td>Honda</td><td>N/A</td><td>N/A</td></t<>	10406748	12/2018	Honda	N/A	N/A
10639843 12/2019 Yuan et al. N/A N/A 10682808 12/2019 Fujita et al. N/A N/A 10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Kuijpers et al. N/A N/A 11179891 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0102682 12/2002 Artz et al. N/A N/A 2003/012038 12/2002 Sherwood N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/003984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Libes et al. N/A N/A 2007/016937 12/2006 Cunningham et al. N/A N/A 2007/016937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/013800 12/2008 Morohoshi et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/013601 12/2009 Das et al. N/A N/A 2010/009016 12/2009 Kaehr et al. N/A N/A 2010/009016 12/2009 Kaehr et al. N/A N/A 2009/0146344 12/2009 Kaehr et al. N/A N/A 2009/013601 12/2009 Kaehr et al. N/A N/A 2011/019694 12/2009 Kaehr et al. N/A N/A 2011/019694 12/2009 Kaehr et al. N/A N/A 2011/019707 12/2010 El-Siblani et al. N/A N/A 2011/019707 12/2010 Docker et al. N/A N/A 2011/010707 12/2010 Hull et al. N/A N/A 2011/010707 12/2010 El-Siblani et al. N/A N/A 2011/02989 12/2010 Docker et al. N/A N/A 2011/010707 12/2010 El-Siblani et al. N/A N/A 2011/010707 12/2011 El-Siblani et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A	10612112	12/2019	Yang et al.	N/A	N/A
10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Kuijpers et al. N/A N/A 11179891 12/2021 Steege N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2003 Puffer, Jr. et al. N/A N/A 2005/0019061 12/2004 Nakashika et al. N/A N/A 2006/0230984 12/2004 Talken N/A N/A 20	10639843	12/2019	<u>o</u>	N/A	N/A
10695988 12/2019 Hanyu et al. N/A N/A 10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Kuijpers et al. N/A N/A 11179891 12/2021 Steege N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0019016 12/2004 Nakashima N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0248062 12/2005 Bredt et al. N/A N/A 2007/0	10682808	12/2019	Fujita et al.	N/A	N/A
10717212 12/2019 Parkinson et al. N/A N/A 10737479 12/2019 El-Siblani et al. N/A N/A 10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Kuijpers et al. N/A N/A 11179891 12/2020 Dubelman et al. N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0180171 12/2002 Kurokawa N/A N/A 2003/0209836 12/2002 Artz et al. N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Bredt et al. N/A N/A 2007/063366 12/2006 Cunningham et al. N/A N/A </td <td>10695988</td> <td>12/2019</td> <td>-</td> <td>N/A</td> <td>N/A</td>	10695988	12/2019	-	N/A	N/A
10994941 12/2020 Dwivedi et al. N/A N/A 11141909 12/2020 Kuijpers et al. N/A N/A N/A 11179891 12/2020 Dubelman et al. N/A N/A N/A 11524457 12/2021 Steege N/A N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A N/A 2003/0102682 12/2002 Artz et al. N/A N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashika et al. N/A N/A 2005/001239 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2007/016937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179187 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0146344 12/2008 El-Siblani N/A N/A 2010/0090619 12/2009 Das et al. N/A N/A 2010/0290016 12/2009 Kaehr et al. N/A N/A 2011/010570 12/2010 El-Siblani et al. N/A N/A 2011/0207057 12/2010 Ducker et al. N/A N/A 2012/0007287 12/2011 El-Siblani et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N	10717212	12/2019		N/A	N/A
11141909 12/2020 Kuijpers et al. N/A N/A 11179891 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0019016 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0230984 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/017912 12/2007 Sperry et al. N/A N/A	10737479	12/2019	El-Siblani et al.	N/A	N/A
11179891 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0180171 12/2002 Kurokawa N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0248062 12/2005 Bredt et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0179112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A	10994941	12/2020	Dwivedi et al.	N/A	N/A
11179891 12/2020 Dubelman et al. N/A N/A 11524457 12/2021 Steege N/A N/A 2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0180171 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2004/029836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0248062 12/2005 Bredt et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/017912 12/2007 Hull et al. N/A N/A 2008/017987 12/2007 Sperry et al. N/A N/A	11141909	12/2020	Kuijpers et al.	N/A	N/A
2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A	11179891	12/2020		N/A	N/A
2002/0164069 12/2001 Nagano et al. N/A N/A 2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/02241404 12/2007 Allaman et al. N/A N/A	11524457	12/2021	Steege	N/A	N/A
2003/0102682 12/2002 Kurokawa N/A N/A 2003/0180171 12/2002 Artz et al. N/A N/A 2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A </td <td>2002/0164069</td> <td>12/2001</td> <td>G</td> <td>N/A</td> <td>N/A</td>	2002/0164069	12/2001	G	N/A	N/A
2003/0209836 12/2002 Sherwood N/A N/A 2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/017912 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/024352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Yamazaki et al. N/A N/A	2003/0102682	12/2002	_	N/A	N/A
2004/0042789 12/2003 Puffer, Jr. et al. N/A N/A 2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0244352 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N	2003/0180171	12/2002	Artz et al.	N/A	N/A
2005/0012239 12/2004 Nakashima N/A N/A 2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/024352 12/2007 Narukawa et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0003619 12/2008 El-Siblani N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A <td>2003/0209836</td> <td>12/2002</td> <td>Sherwood</td> <td>N/A</td> <td>N/A</td>	2003/0209836	12/2002	Sherwood	N/A	N/A
2005/0019016 12/2004 Nakashika et al. N/A N/A 2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0093619 12/2008 El-Siblani N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/	2004/0042789	12/2003	Puffer, Jr. et al.	N/A	N/A
2005/0056677 12/2004 Talken N/A N/A 2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2006 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0003619 12/2008 El-Siblani N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A </td <td>2005/0012239</td> <td>12/2004</td> <td>Nakashima</td> <td>N/A</td> <td>N/A</td>	2005/0012239	12/2004	Nakashima	N/A	N/A
2006/0230984 12/2005 Bredt et al. N/A N/A 2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2007/0116937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A <td>2005/0019016</td> <td>12/2004</td> <td>Nakashika et al.</td> <td>N/A</td> <td>N/A</td>	2005/0019016	12/2004	Nakashika et al.	N/A	N/A
2006/0248062 12/2005 Libes et al. N/A N/A 2007/0063366 12/2006 Cunningham et al. N/A N/A 2007/0116937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0003619 12/2008 El-Siblani N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/	2005/0056677	12/2004	Talken	N/A	N/A
2007/0063366 12/2006 Cunningham et al. N/A N/A 2007/0116937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/0003619 12/2008 El-Siblani N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0290016 12/2009 Kaehr et al. N/A N/A 2011/089610 12/2010 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A	2006/0230984	12/2005	Bredt et al.	N/A	N/A
2007/0116937 12/2006 Lazzerini N/A N/A 2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2010/090146344 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0290016 12/2009 Kaehr et al. N/A N/A 2011/089610 12/2010 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A	2006/0248062	12/2005	Libes et al.	N/A	N/A
2008/0170112 12/2007 Hull et al. N/A N/A 2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0290016 12/2009 Kaehr et al. N/A N/A 2011/089610 12/2010 El-Siblani et al. N/A N/A 2011/010570 12/2010 John et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A	2007/0063366	12/2006	Cunningham et al.	N/A	N/A
2008/0179787 12/2007 Sperry et al. N/A N/A 2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0290016 12/2009 Kaehr et al. N/A N/A 2011/089610 12/2010 El-Siblani et al. N/A N/A 2011/01570 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2007/0116937	12/2006	Lazzerini	N/A	N/A
2008/0224352 12/2007 Narukawa et al. N/A N/A 2008/0241404 12/2007 Allaman et al. N/A N/A 2009/0133800 12/2008 Morohoshi et al. N/A N/A 2009/0146344 12/2008 El-Siblani N/A N/A 2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2011/0290016 12/2009 Kaehr et al. N/A N/A 2011/089610 12/2010 El-Siblani et al. N/A N/A 2011/010570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2012/0007287 12/2010 Hull et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2008/0170112	12/2007	Hull et al.	N/A	N/A
2008/024140412/2007Allaman et al.N/AN/A2009/013380012/2008Morohoshi et al.N/AN/A2009/014634412/2008El-SiblaniN/AN/A2010/000361912/2009Das et al.N/AN/A2010/019669412/2009Yamazaki et al.N/AN/A2010/029001612/2009Kaehr et al.N/AN/A2011/008961012/2010El-Siblani et al.N/AN/A2011/01057012/2010John et al.N/AN/A2011/016298912/2010Ducker et al.N/AN/A2011/020705712/2010Hull et al.N/AN/A2012/000728712/2011Vermeer et al.N/AN/A2012/019599412/2011El-Siblani et al.N/AN/A2012/029280012/2011Higuchi et al.N/AN/A	2008/0179787	12/2007	Sperry et al.	N/A	N/A
2009/013380012/2008Morohoshi et al.N/AN/A2009/014634412/2008El-SiblaniN/AN/A2010/000361912/2009Das et al.N/AN/A2010/019669412/2009Yamazaki et al.N/AN/A2010/029001612/2009Kaehr et al.N/AN/A2011/008961012/2010El-Siblani et al.N/AN/A2011/010157012/2010John et al.N/AN/A2011/016298912/2010Ducker et al.N/AN/A2011/020705712/2010Hull et al.N/AN/A2012/000728712/2011Vermeer et al.N/AN/A2012/019599412/2011El-Siblani et al.N/AN/A2012/029280012/2011Higuchi et al.N/AN/A	2008/0224352	12/2007	Narukawa et al.	N/A	N/A
2009/014634412/2008El-SiblaniN/AN/A2010/000361912/2009Das et al.N/AN/A2010/019669412/2009Yamazaki et al.N/AN/A2010/029001612/2009Kaehr et al.N/AN/A2011/008961012/2010El-Siblani et al.N/AN/A2011/010157012/2010John et al.N/AN/A2011/016298912/2010Ducker et al.N/AN/A2011/020705712/2010Hull et al.N/AN/A2012/000728712/2011Vermeer et al.N/AN/A2012/019599412/2011El-Siblani et al.N/AN/A2012/029280012/2011Higuchi et al.N/AN/A	2008/0241404	12/2007	Allaman et al.	N/A	N/A
2010/0003619 12/2009 Das et al. N/A N/A 2010/0196694 12/2009 Yamazaki et al. N/A N/A 2010/0290016 12/2009 Kaehr et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0101570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2009/0133800	12/2008	Morohoshi et al.	N/A	N/A
2010/0196694 12/2009 Yamazaki et al. N/A N/A 2010/0290016 12/2009 Kaehr et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0101570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2009/0146344	12/2008	El-Siblani	N/A	N/A
2010/0290016 12/2009 Kaehr et al. N/A N/A 2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0101570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2010/0003619	12/2009	Das et al.	N/A	N/A
2011/0089610 12/2010 El-Siblani et al. N/A N/A 2011/0101570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2010/0196694	12/2009	Yamazaki et al.	N/A	N/A
2011/0101570 12/2010 John et al. N/A N/A 2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2010/0290016	12/2009	Kaehr et al.	N/A	N/A
2011/0162989 12/2010 Ducker et al. N/A N/A 2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A	2011/0089610	12/2010	El-Siblani et al.	N/A	N/A
2011/0207057 12/2010 Hull et al. N/A N/A 2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A		12/2010	John et al.	N/A	N/A
2012/0007287 12/2011 Vermeer et al. N/A N/A 2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A		12/2010		N/A	N/A
2012/0195994 12/2011 El-Siblani et al. N/A N/A 2012/0292800 12/2011 Higuchi et al. N/A N/A		12/2010	Hull et al.	N/A	N/A
2012/0292800 12/2011 Higuchi et al. N/A N/A		12/2011		N/A	
8					
2012/0313294 12/2011 Vermeer et al. N/A N/A			_		
	2012/0313294	12/2011	Vermeer et al.	N/A	N/A

2013/0052332 12/2012 Roof et al. N/A N 2013/0140741 12/2012 El-Siblani et al. N/A N 2013/0241113 12/2012 Geers et al. N/A N 2014/0099476 12/2013 Subramanian et al. N/A N 2014/0103581 12/2013 Das et al. N/A N 2014/0191442 12/2013 Elsey N/A N 2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2013/0140741 12/2012 El-Siblani et al. N/A N 2013/0241113 12/2012 Geers et al. N/A N 2014/0099476 12/2013 Subramanian et al. N/A N 2014/0103581 12/2013 Das et al. N/A N 2014/0191442 12/2013 Elsey N/A N 2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0339741 12/2013 Fockele N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2013/0241113 12/2012 Geers et al. N/A N 2014/0099476 12/2013 Subramanian et al. N/A N 2014/0103581 12/2013 Das et al. N/A N 2014/0191442 12/2013 Elsey N/A N 2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0103581 12/2013 Das et al. N/A N 2014/0191442 12/2013 Elsey N/A N 2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0348691 12/2013 Aghababaie et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0103581 12/2013 Das et al. N/A N 2014/0191442 12/2013 Elsey N/A N 2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0348691 12/2013 Aghababaie et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/019144212/2013ElseyN/AN2014/020086512/2013Lehmann et al.N/AN2014/023955412/2013El-Siblani et al.N/AN2014/024681312/2013Bauman et al.N/AN2014/027531712/2013MoussaN/AN2014/031973512/2013El-Siblani et al.N/AN2014/032237412/2013El-Siblani et al.N/AN2014/033250712/2013FockeleN/AN2014/033974112/2013Aghababaie et al.N/AN2014/034869112/2013Ljungblad et al.N/AN2014/034869212/2013Bessac et al.N/AN	/A
2014/0200865 12/2013 Lehmann et al. N/A N 2014/0239554 12/2013 El-Siblani et al. N/A N 2014/0246813 12/2013 Bauman et al. N/A N 2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0246813 12/2013 Bauman et al. N/A N 2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0275317 12/2013 Moussa N/A N 2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0319735 12/2013 El-Siblani et al. N/A N 2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0322374 12/2013 El-Siblani et al. N/A N 2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0332507 12/2013 Fockele N/A N 2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0339741 12/2013 Aghababaie et al. N/A N 2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0348691 12/2013 Ljungblad et al. N/A N 2014/0348692 12/2013 Bessac et al. N/A N	/A
2014/0348692 12/2013 Bessac et al. N/A N	/A
	/A
2015/0004042 12/2014 NT 1 NT/A NT	/A
2015/0004042 12/2014 Nimal N/A N	/A
2015/0004046 12/2014 Graham et al. N/A N	/A
2015/0056365 12/2014 Miyoshi N/A N	/A
2015/0086409 12/2014 Hellestam N/A N	/A
2015/0102531 12/2014 El-Siblani et al. N/A N	/A
2015/0104563 12/2014 Lowe et al. N/A N	/A
2015/0140152 12/2014 Chen N/A N	/A
2015/0140155 12/2014 Ohno et al. N/A N	/A
2015/0145174 12/2014 Comb N/A N	/A
2015/0158111 12/2014 Schwarze et al. N/A N	/A
2015/0165695 12/2014 Chen et al. N/A N	/A
	/A
2015/0224710 12/2014 El-Siblani N/A N	/A
	/A
	/A
	/A
	/A
78	/A
	/A
O Company of the comp	/A
	/A
	/A
3 8	/A
	/A
8	/A
	/A
	/A
	/A
8	/A
	/A
	/A
	/A
	/A
2016/0052205 12/2015 FrantzDale N/A N	/ /\
2016/0059484 12/2015 DeSimone et al. N/A N	

2016/0059485 12/2015 Ding et al. N/A 2016/0067921 12/2015 Willis et al. N/A	
	N/A
2016/0082662 12/2015 Majer N/A	
2016/0082671 12/2015 Joyce N/A	
2016/0096332 12/2015 Chen et al. N/A	N/A
2016/0107340 12/2015 Joyce N/A	
2016/0107383 12/2015 Dikovsky et al. N/A	
2016/0107387 12/2015 Ooba et al. N/A	N/A
2016/0129631 12/2015 Chen et al. N/A	N/A
2016/0137839 12/2015 Rolland et al. N/A	N/A
2016/0167160 12/2015 Hellestam N/A	N/A
2016/0176114 12/2015 Tsai et al. N/A	N/A
2016/0184931 12/2015 Green N/A	N/A
2016/0193785 12/2015 Bell et al. N/A	N/A
2016/0200052 12/2015 Moore et al. N/A	N/A
2016/0214327 12/2015 Ucklemann et al. N/A	N/A
2016/0221262 12/2015 Das et al. N/A	N/A
2016/0223117 12/2015 Hitzelberger N/A	N/A
2016/0243649 12/2015 Zheng et al. N/A	N/A
2016/0303798 12/2015 Mironets et al. N/A	N/A
2016/0332386 12/2015 Kuijpers N/A	N/A
2016/0361871 12/2015 Jeng et al. N/A	N/A
2016/0361872 12/2015 El-Siblani N/A	N/A
2017/0008234 12/2016 Cullen et al. N/A	N/A
2017/0008236 12/2016 Easter et al. N/A	N/A
2017/0021562 12/2016 El-Siblani et al. N/A	N/A
2017/0028472 12/2016 Shaw et al. N/A	N/A
2017/0066185 12/2016 Ermoshkin et al. N/A	N/A
2017/0066196 12/2016 Beard et al. N/A	
2017/0072635 12/2016 El-Siblani et al. N/A	N/A
2017/0080641 12/2016 El-Siblani N/A	N/A
2017/0087670 12/2016 Kalentics et al. N/A	N/A
2017/0100895 12/2016 Chou et al. N/A	
2017/0100897 12/2016 Chou et al. N/A	
2017/0100899 12/2016 El-Siblani et al. N/A	
2017/0102679 12/2016 Greene et al. N/A	
2017/0113409 12/2016 Patrov N/A	
2017/0120332 12/2016 DeMuth et al. N/A	
2017/0120333 12/2016 DeMuth et al. N/A	
2017/0120334 12/2016 DeMuth et al. N/A	
2017/0120335 12/2016 DeMuth et al. N/A	
2017/0120336 12/2016 DeMuth et al. N/A	
2017/0120387 12/2016 DeMuth et al. N/A	
2017/0120518 12/2016 DeMuth et al. N/A	
2017/0120529 12/2016 DeMuth et al. N/A	
2017/0120530 12/2016 DeMuth et al. N/A	
2017/0120537 12/2016 DeMuth et al. N/A	
2017/0120538 12/2016 DeMuth et al. N/A	
2017/0123222 12/2016 DeMuth et al. N/A	
2017/0123237 12/2016 DeMuth et al. N/A	
2017/0136688 12/2016 Knecht et al. N/A	
2017/0136708 12/2016 Das et al. N/A	N/A

2017/0157841	12/2016	Green	N/A	N/A
2017/0157862	12/2016	Bauer	N/A	N/A
2017/0165916	12/2016	El-Siblani	N/A	N/A
2017/0173865	12/2016	Dikovsky et al.	N/A	N/A
2017/0182708	12/2016	Lin et al.	N/A	N/A
2017/0190120	12/2016	Bloome et al.	N/A	N/A
2017/0276651	12/2016	Hall	N/A	N/A
2017/0284971	12/2016	Hall	N/A	N/A
2017/0291804	12/2016	Craft et al.	N/A	N/A
2017/0297108	12/2016	Gibson et al.	N/A	N/A
2017/0297109	12/2016	Gibson et al.	N/A	N/A
2017/0297261	12/2016	Schultheiss et al.	N/A	N/A
2017/0305136	12/2016	Elsey	N/A	N/A
2017/0326786	12/2016	Yuan et al.	N/A	N/A
2017/0326807	12/2016	Greene et al.	N/A	N/A
2017/0368816	12/2016	Batchelder et al.	N/A	N/A
2018/0001567	12/2017	Juan et al.	N/A	N/A
2018/0015672	12/2017	Shusteff et al.	N/A	N/A
2018/0043619	12/2017	Kim et al.	N/A	N/A
2018/0056585	12/2017	Du Toit	N/A	N/A
2018/0056604	12/2017	Sands et al.	N/A	N/A
2018/0079137	12/2017	Herzog et al.	N/A	N/A
2018/0085998	12/2017	Von Burg	N/A	N/A
2018/0117790	12/2017	Yun	N/A	N/A
2018/0134029	12/2017	Myerberg et al.	N/A	N/A
2018/0162045	12/2017	Guimbretiere	N/A	N/A
2018/0169969	12/2017	Deleon et al.	N/A	N/A
2018/0200948	12/2017	Kuijpers	N/A	B29C 64/129
2018/0201021	12/2017	Beaver et al.	N/A	N/A
2018/0229332	12/2017	Tsai et al.	N/A	N/A
2018/0229436	12/2017	Gu et al.	N/A	N/A
2018/0272603	12/2017	MacCormack et al.	N/A	N/A
2018/0272608	12/2017	Yun	N/A	N/A
2018/0304369	12/2017	Myerberg et al.	N/A	N/A
2018/0345600	12/2017	Holford et al.	N/A	N/A
2018/0370214	12/2017	Comb et al.	N/A	N/A
2019/0022937	12/2017	Stelter et al.	N/A	N/A
2019/0039299	12/2018	Busbee et al.	N/A	N/A
2019/0047211	12/2018	Herring et al.	N/A	N/A
2019/0061230	12/2018	Ermoshkin et al.	N/A	N/A
2019/0070777	12/2018	Wu et al.	N/A	N/A
2019/0105622	12/2018	Lewis	N/A	B01F 33/30
2019/0112499	12/2018	Rolland et al.	N/A	N/A
2019/0126533	12/2018	Thompson	N/A	N/A
2019/0126548	12/2018	Barnhart et al.	N/A	N/A
2019/0146344	12/2018	Shimoaoki et al.	N/A	N/A
2019/0232369	12/2018	Strobner et al.	N/A	N/A
2019/0232550	12/2018	Mark et al.	N/A	N/A
2019/0240932	12/2018	Graf	N/A	N/A
2019/0263054	12/2018	Kotler et al.	N/A	N/A
2019/0270254	12/2018	Mark et al.	N/A	N/A
2019/0283316	12/2018	Rolland et al.	N/A	N/A
_010,0200010	1 <i>4</i> / 4010	Romana et al.	1 1/1 1	1 1/1 1

	01670477	12/2000	CN	NI/A	
	atent No.	Application Date	Country	CPC	
F	OREIGN PATEN	T DOCUMENTS			
2	023/0067394	12/2022	Barnhill et al.	N/A	N/A
	023/0064479	12/2022	Barnhill et al.	N/A	N/A
	023/0050127	12/2022	Duebelman et al.	N/A	N/A
	023/0012168	12/2022	Dubelman et al.	N/A	N/A
	022/0410486	12/2021	Liu et al.	N/A	N/A
	022/0410482	12/2021	Dubelman et al.	N/A	N/A
	022/0410481	12/2021	Muhlenkamp et al.	N/A	N/A
	022/0402212	12/2021	Dubelman et al.	N/A	N/A
	022/0402198	12/2021	Thompson et al.	N/A	N/A
	022/0339859	12/2021	Steele et al.	N/A	N/A
	022/0274335	12/2021	Thompson et al.	N/A	N/A
	022/0161488	12/2021	Dubelman et al.	N/A	N/A
	022/0088868	12/2021	Duoss et al.	N/A	N/A
	022/0040921	12/2021	Dubelman et al.	N/A	N/A
	021/0402677	12/2020	Khusnatdinov et al.	N/A	N/A
	021/0316367	12/2020	Padilla et al.	N/A	N/A
	021/0187859	12/2020	Gmeiner et al.	N/A	N/A
	021/0156779	12/2020	Medalsy	N/A	N/A
	021/0046695	12/2020	Thompson et al.	N/A	N/A
	021/0023776	12/2020	Van Esbroeck et al.	N/A	N/A
	020/0376775	12/2019	Das et al.	N/A	N/A
	020/0307100	12/2019	Sabo	N/A	N/A
	020/0307075	12/2019	Mattes et al.	N/A	N/A
	020/0298485	12/2019	Tsai	N/A	N/A
	020/0290275	12/2019	Dubelman et al.	N/A	N/A
	020/0262150	12/2019	Dubelman et al.	N/A	N/A
	020/0247040	12/2019	Green	N/A	N/A
	020/0238624	12/2019	Dubelman et al.	N/A	N/A
2	020/0230938	12/2019	Menchik et al.	N/A	N/A
	020/0198224	12/2019	Dubelman et al.	N/A	N/A
	020/0164437	12/2019	Goth et al.	N/A	N/A
	020/0108553	12/2019	Rogren	N/A	N/A
2	020/0101564	12/2019	Shibazaki	N/A	N/A
	020/0079017	12/2019	MacNeish, III et al.	N/A	N/A
2	020/0079008	12/2019	Chowdry et al.	N/A	N/A
2	020/0039142	12/2019	Childers	N/A	N/A
2	020/0001525	12/2019	Wynne et al.	N/A	N/A
2	020/0001398	12/2019	Mellor et al.	N/A	N/A
2	019/0389137	12/2018	Frohnmaier et al.	N/A	N/A
	019/0344381	12/2018	Pomerantz et al.	N/A	N/A
	019/0315064	12/2018	Budge et al.	N/A	N/A
2	019/0299524	12/2018	Hill et al.	N/A	N/A

			0_ 0
101628477	12/2009	CN	N/A
103210344	12/2012	CN	N/A
103522546	12/2013	CN	N/A
104175559	12/2013	CN	N/A
104647752	12/2014	CN	N/A
105711101	12/2015	CN	N/A
105773962	12/2015	CN	N/A
107322930	12/2016	CN	N/A

109968661 12/2018 CN N/A 111497231 12/2019 CN N/A 102007010624 12/2007 DE N/A 448459 12/1990 EP N/A 557051 12/1992 EP N/A 1454831 12/2003 EP N/A 1852244 12/2006 EP N/A 1946908 12/2007 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 2311960 12/1996 GB N/A 406246839 12/1993 JP N/A 4002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729	208946717	12/2018	CN	N/A
102007010624 12/2007 DE N/A 448459 12/1990 EP N/A 557051 12/1992 EP N/A 1454831 12/2003 EP N/A 1852244 12/2006 EP N/A 1864785 12/2006 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2016/196098 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422	109968661	12/2018	CN	N/A
448459 12/1990 EP N/A 557051 12/1992 EP N/A 1454831 12/2003 EP N/A 1852244 12/2006 EP N/A 1864785 12/2006 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 406246839 12/1996 GB N/A H06246839 12/1993 JP N/A 2002/370286 12/2001 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9806560	111497231	12/2019	CN	N/A
557051 12/1992 EP N/A 1454831 12/2003 EP N/A 1852244 12/2006 EP N/A 1864785 12/2006 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A 4002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9806560 12/1997 WO N/A WO0100390	102007010624	12/2007	DE	N/A
1454831 12/2003 EP N/A 1852244 12/2006 EP N/A 1864785 12/2006 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	448459	12/1990	EP	N/A
1852244 12/2006 EP N/A 1864785 12/2007 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	557051	12/1992	EP	N/A
1864785 12/2006 EP N/A 1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A 4002/370286 12/2091 JP N/A 2003/039564 12/2001 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	1454831	12/2003	EP	N/A
1946908 12/2007 EP N/A 2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2014/090210 12/2003 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	1852244	12/2006	EP	N/A
2521524 12/2011 EP N/A 3053729 12/2015 EP N/A 3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2014/090210 12/2003 JP N/A 2016/196098 12/2013 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	1864785	12/2006	EP	N/A
3053729 12/2015 EP N/A 3453521 12/2019 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	1946908	12/2007	EP	N/A
3453521 12/2018 EP N/A 3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2521524	12/2011	EP	N/A
3356121 12/2019 EP N/A 2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	3053729	12/2015	EP	N/A
2311960 12/1996 GB N/A H06246839 12/1993 JP N/A H07164534 12/1994 JP N/A 2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	3453521	12/2018	EP	N/A
H0624683912/1993JPN/AH0716453412/1994JPN/A2002/37028612/2001JPN/A2003/03956412/2002JPN/A2004/25792912/2003JPN/A2014/09021012/2013JPN/A2016/19609812/2015JPN/A2017010872912/2016KRN/A10210966412/2019KRN/AWO960042212/1995WON/AWO980656012/1997WON/AWO010039012/2000WON/A	3356121	12/2019	EP	N/A
H0716453412/1994JPN/A2002/37028612/2001JPN/A2003/03956412/2002JPN/A2004/25792912/2003JPN/A2014/09021012/2013JPN/A2016/19609812/2015JPN/A2017010872912/2016KRN/A10210966412/2019KRN/AWO960042212/1995WON/AWO980656012/1997WON/AWO010039012/2000WON/A	2311960	12/1996	GB	N/A
2002/370286 12/2001 JP N/A 2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	H06246839	12/1993	JP	N/A
2003/039564 12/2002 JP N/A 2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	H07164534	12/1994	JP	N/A
2004/257929 12/2003 JP N/A 2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2002/370286	12/2001	JP	N/A
2014/090210 12/2013 JP N/A 2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2003/039564	12/2002	JP	N/A
2016/196098 12/2015 JP N/A 20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2004/257929	12/2003	JP	N/A
20170108729 12/2016 KR N/A 102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2014/090210	12/2013	JP	N/A
102109664 12/2019 KR N/A WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	2016/196098	12/2015	JP	N/A
WO9600422 12/1995 WO N/A WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	20170108729	12/2016	KR	N/A
WO9806560 12/1997 WO N/A WO0100390 12/2000 WO N/A	102109664	12/2019	KR	N/A
WO0100390 12/2000 WO N/A	WO9600422	12/1995	WO	N/A
	WO9806560	12/1997	WO	N/A
TATO 2000 /07700	WO0100390	12/2000	WO	N/A
	WO2006/077665	12/2005	WO	N/A
WO2006/109355 12/2005 WO N/A	WO2006/109355	12/2005	WO	N/A
WO2017/009368 12/2016 WO N/A		12/2016	WO	
WO2017/098968 12/2016 WO N/A				
WO2017/100538 12/2016 WO N/A				
WO2019/159936 12/2018 WO N/A				
WO2020/033607 12/2019 WO N/A				
WO2020/185553 12/2019 WO N/A	WO2020/185553	12/2019	WO	N/A

OTHER PUBLICATIONS

Admatec, Admaflex 300 DLP 3D Printer, Specifications, Features, Design and Functions, Netherlands, 2 Pages. Retrieved Nov. 5, 2020 from Webpage:

https://admateceurope.com/files/10fla369c2239943e6506f27ba920bd4dd9359078e744369695ab6ffbde75c6c3filenaname=Admaflex%20300%20brochure.pdf&sig=hQvDIzxkSmFOZwjM. cited by applicant

Carbon, Carbon SpeedCell: Additive Manufacturing Reinvented, Redwood City California, Mar. 16, 2017, 4 Pages. Retrieved from Webpage: https://www.carbon3d.com/news/carbon-speedcell-adiitive-manufacturing-reinvented/. cited by applicant

Carbon, The 3D Printer for Products that Outperform, 8 Pages. Retrieved from Webpage: https://www.carbon3d.com. cited by applicant

DDM Systems, Disruptive Technologies for Additive Manufacturing, 2014. Retrieved on Jul. 7, 2020 from Web Link: http://www.ddmsys.com/. cited by applicant

Designing Buildings Wiki, Types of Brick Bonding, 6 Pages. Retrieved Mar. 25, 2021 from Webpage:

https://www.designingbuildings.co.uk/wiki/Types_of_brick_bonding.cited by applicant

Doctor Blade with Micrometer Screw Gauge, The Tape Casting Warehouse, Inc., Morrisville PA, 6 Pages.

Retrieved Mar. 23, 2021 from Webpage: https://www.drblade.com/. cited by applicant

Envisiontec, Advanced DLP for Superior 3D Printing, Mar. 9, 2017, 8 Pages. https://envisiontec.com/wp-content/uploads/2016/12/Why-EnvisionTEC-DLP-3D-Printing-is-Better-rebranded.pdf. cited by applicant Feng et al., Exposure Reciprocity Law in Photopolymerization of Multi-Functional Acrylates and Methacrylates, Macromolecular Chemistry and Physics, vol. 208, 2007, pp. 295-306. cited by applicant Formlabs, An Introduction to Post-Curing SLA 3D Prints, 8 Pages. Retrieved from Webpage: https://formlabs.com/blog/introduction-post-curing-sla-3d-prints. cited by applicant Formlabs, Form Wash & Form Cure, 8 Pages. Retrieved from Webpage: https://formlabs.com/tools/wash-

Hafkamp et al., A Feasibility Study on Process Monitoring and Control in Vat Photopolymerization of Ceramics, Mechatronics, vol. 56, The Netherlands, Dec. 2018, pp. 220-241. Retrieved from:

https://dori.org/10.1016/j.mechatronics.2018.02.006. cited by applicant

cure. cited by applicant

Kudo3D, Post-Process Your SLA Prints in 4 Easy Steps, 8 Pages. Retrieved from Webpage: https://www.kudo3d.com/post-process-your-sla-prints-in-4-easy-steps/. cited by applicant

Leap, Low-Frequency Sonic Mixing Technology, Energy Efficiency & Renewable Energy, Energy.Gov, 5 Pages. Retrieved Mar. 17, 2021 from Webpage: https://www.energy.gov/eere/amo/low-frequency-sonic-mixing-technology. cited by applicant

Lee et al., Development of a 3D Printer Using Scanning Projection Stereolithography, Scientific Reports, vol. 5, Article No. 9875, 2015, 5 pages. https://www.nature.com/articles/srep09875#s1. cited by applicant Lee et al., Large-Area Compatible Laser Sintering Schemes with a Spatially Extended Focused Beam, Journal, Micromachines, vol. 8, No. 153, Seoul University, Seoul Korea, May 11, 2017, 8 Pages. http://dx.doi.org/10.3390/mi8050153. cited by applicant

Limaye, Multi-Objective Process Planning Method for Mask Projection Stereolithography, Dissertation Georgia Institute of Technology, Dec. 2007, 324 Pages. cited by applicant

Lithoz, 2 Pages. Retrieved from Webpage: http://www.lithoz.com/en/our-products/cleaning-station. cited by applicant

Matthews et al., Diode-Based Additive Manufacturing of Metals Using an Optically-Addressable Light Valve, Optic Express Research Article, vol. 25, No. 10, Lawrence Livermore National Laboratory, Livermore CA, May 10, 2017. cited by applicant

Micron3D, Cleaning of Printed Models, YouTube, Dec. 5, 2016, 1 Page. Retrieved from Webpage: https://www.youtube.com/watch?v=soAIrSsliBY. cited by applicant

Nussbaum et al., Evaluation of Processing Variables in Large Area Polymer Sintering of Single Layer Components, Solid Freeform Fabrication 2016: Proceedings of the 27.SUP.th .Annual International Solid Freeform Fabracation Symposium—An Additive Manufacturing Conference Reviewed Paper, University of South Florida, Tampa Florida. cited by applicant

Omegasonics, Ultrasonic Cleaning of 3D Printer Parts, YouTube, Feb. 26, 2014, 1 Page. Retrieved from Webpage: https://www.youtube.com/watch?v=Gxj47O85ohk. cited by applicant

Park et al., Development of Multi-Material DLP 3D Printer, Journal of the Korean Society of Manufacturing Technology Engineers, vol. 26, Issue 1, Seoul Korea, Feb. 15, 2017, pp. 100-107.

https://doi.org/10.7735/ksmte.2017.26.1.100. cited by applicant

Prodways Tech, Prodways Movinglight Technology Retrieved on Jul. 2, 2020 from Web Link:

https://www.prodways.com/en/the-prodways-movinglight-technology/. cited by applicant

Ramco Equipment Corporation, Ramco RamTough—Fully Automated Wash/Rinse/Dry System, YouTube, Jul. 9, 2013, 1 Page. Retrieved from Webpage: https://www.youtube.com/watch?v=i8S5Oc3FVFU. cited by applicant

Ricoh Imaging Company Ltd., The Advanced Pixel Shift Resolution System II for Super-High-Resolution Images, Pentax K-1 Mark II, Pixel Shift Resolution System, 4 Pages. Retrieved on Mar. 30, 2021 from Webpage: http://www.ricoh-imaging.co.jp/english/products/k-1-2/feature/02.html. cited by applicant Sonics & Materials, Inc., Ultrasonic Food Cutting Equipment, Sonics & Materials, Inc., Retrieved on Jun. 26, 2020, 4 Pages. https://www.sonics.com/food-cutting. cited by applicant

Stemmer Imaging, Ultra-High Resolution for Industrial Imaging, Germany, 9 Pages. Retrieved on Mar. 30, 2021 from Webpage: https://www.stemmer-imaging.com/en/knowledge-base/pixel-shift-technology/. cited by applicant

Stevenson, Admatec's Ceramic 3D Printers, Ceramic, Metal, Fabbaloo 3D Printing News, Jan. 21, 2019, 8 Pages. Retrieved Nov. 24, 2020 from Weblink: https://www.fabbaloo.com/blog/2019/1/21/admatecs-ceramic-3d-printers. cited by applicant

Techmetals, Electroless Nickel (TM 117C), Engineered Metal Finishing & Performance Coatings, 1 Page. Retrieved from Webpage: https://techmetals.com/pdfs/TM_117C.pdf https://techmetals.com/tm117c-2/. cited by applicant

Telsonic Ultrasonics, Cutting Awning Fabrics and Sealing the Edge, The Powerhouse of Ultrasonics, 2017, 1 Page. https://www.telsonic.com/fileadmin/applications/AS_206_Cut_Seal_Markisengewebe_EN.pdf. cited by applicant

Telsonic Ultrasonics, Integrated Power Actuator—IPA 3505, Telsonic Ultrasonics, Retrieved Jun. 26, 2020, 2 Pages. https://www.telsonic.com/en/products/integrated-power-actuator-ipa-3505/. cited by applicant Tok et al., Tape Casting of High Dielectric Ceramic Substrates for Microelectronics Packaging, Journal of Materials Engineering and Performance, vol. 8, 1999, pp. 469-472. (Abstract Only) https://link.springer.com/article/10.1361/105994999770346783. cited by applicant Wikipedia, Pixel Shifting, 2 Pages. Retrieved Mar. 30, 2021 from Webpage: https://en.wikipedia.org/wiki/Pixel_shifting. cited by applicant Wikipedia, Standing Wave, 11 Pages. Retrieved Mar. 17, 2021 from Webpage: https://en.wikipedia.org/wiki/Standing-wave. cited by applicant

Primary Examiner: Nelson; Jamel M

Attorney, Agent or Firm: Dinsmore & Shohl LLP

Background/Summary

CROSS-REFERENCE TO RELATED APPLICATION (1) This application is a continuation application of U.S. patent application Ser. No. 17/371,484, filed on Jul. 9, 2021, the disclosure of which is incorporated by reference herein in its entirety.

FIELD

- (1) The present subject matter relates generally to an additive manufacturing apparatus, and more particularly to a resin management system for the additive manufacturing apparatus. BACKGROUND
- (2) Additive manufacturing is a process in which material is built up layer-by-layer to form a component. Stereolithography (SLA) is a type of additive manufacturing process, which employs a vessel of radiant-energy curable photopolymer "resin" and a curing energy source, such as a laser. Similarly, Digital Light Processing (DLP) three-dimensional (3D) printing employs a two-dimensional image projector to build components one layer at a time. For each layer, the energy source draws or flashes a radiation image of the cross section of the component onto the surface of the resin. Exposure to the radiation cures and solidifies the pattern in the resin and joins it to a previously cured layer. (3) In some instances, additive manufacturing may be accomplished through a "tape casting" process. In this process, a resin is deposited onto a resin support, which may be a flexible radiotransparent tape, a foil, and/or another type of resin support, that is fed out from a supply reel to a build zone. Radiant energy is used to cure the resin to a component that is supported by a stage in the build zone. Once the curing of the first layer is complete, the stage and the resin support are separated from one another. The resin support is then advanced and fresh resin is provided to the build zone. In turn, the first layer of the cured resin is placed onto the fresh resin and cured through the energy device to form an additional layer of the component. Subsequent layers are added to each previous layer until the component is completed.
- (4) In operation, as each layer of the component is formed, resin may be deposited on the resin support for forming the next sequential layer of the component. A first portion of the resin may be cured, and a

second portion may be translated out of the build zone. Accordingly, it may be beneficial for the additive manufacturing apparatus to include a resin management system that manages the deposition of the resin onto the resin support and/or the reclamation of the second portion of the resin. BRIEF DESCRIPTION

- (5) Aspects and advantages of the present disclosure will be set forth in part in the following description, or may be obvious from the description, or may be learned through practice of the present disclosure.
- (6) In some embodiments of the present disclosure, an additive manufacturing apparatus includes a stage configured to hold a component. A radiant energy device is operable to generate and project radiant energy in a patterned image. An actuator is configured to change a relative position of the stage relative to the radiant energy device. A resin management system includes a material deposition assembly upstream of the stage and is configured to deposit a resin on a resin support. The material deposition assembly includes a reservoir configured to retain a first volume of the resin, a vessel separated from the reservoir and configured to store a second volume of the resin, and an impeller positioned within the vessel and configured to agitate the resin within the vessel.
- (7) In some embodiments of the present disclosure, a method of operating an additive manufacturing apparatus includes operably coupling a bracket of a first vessel with a brace of said additive manufacturing apparatus. The method also includes coupling a conduit to direct a resin within the first vessel to a reservoir. The method further includes actuating a regulator to allow the resin to be gravity fed from the first vessel to the reservoir.
- (8) In some embodiments of the present disclosure, an additive manufacturing apparatus includes a stage configured to hold one or more cured layers of a resin that form a component. A radiant energy device is positioned opposite to the stage such that it is operable to generate and project radiant energy in a patterned image. A resin management system includes a reclamation system downstream of the stage. The reclamation system includes a collection structure configured to remove at least a portion of the resin from a resin support. The reclamation system further includes a vessel configured to retain the resin removed from the resin support. An impeller positioned within the vessel and configured to agitate the resin within the vessel.
- (9) These and other features, aspects, and advantages of the present disclosure will become better understood with reference to the following description and appended claims. The accompanying drawings, which are incorporated in and constitute a part of this specification, illustrate embodiments of the present disclosure and, together with the description, serve to explain the principles of the present disclosure.

Description

BRIEF DESCRIPTION OF THE DRAWINGS

- (1) A full and enabling disclosure of the present disclosure, including the best mode thereof, directed to one of ordinary skill in the art, is set forth in the specification, which makes reference to the appended figures.
- (2) FIG. **1** is a schematic side view of an additive manufacturing apparatus in accordance with various aspects of the present disclosure;
- (3) FIG. **2** is a front perspective view of a feed panel configured to support one or more components of a feed module in accordance with various aspects of the present disclosure;
- (4) FIG. **3** is a rear perspective view of the feed panel of the feed module in accordance with various aspects of the present disclosure;
- (5) FIG. **4** is a front perspective view of a take-up panel configured to support one or more components of a take-up module in accordance with various aspects of the present disclosure;
- (6) FIG. **5** is a rear perspective view of the take-up panel of the take-up module in accordance with various aspects of the present disclosure;
- (7) FIG. **6** is a schematic view of a material deposition assembly in accordance with various aspects of the present disclosure;

- (8) FIG. 7 is a side perspective view of a vessel of the material deposition assembly in accordance with various aspects of the present disclosure;
- (9) FIG. **8** is a rear perspective view of the material deposition assembly in accordance with various aspects of the present disclosure;
- (10) FIG. **9** is a schematic view of a material deposition assembly in accordance with various aspects of the present disclosure;
- (11) FIG. **10** is a front perspective view of the material deposition assembly in accordance with various aspects of the present disclosure;
- (12) FIG. **11** is a cross-sectional view of the material deposition assembly of FIG. **10** taken along the line XI-XI;
- (13) FIG. **12** is a perspective view of a conduit fluidly coupled with a reservoir of the material deposition assembly in accordance with various aspects of the present disclosure;
- (14) FIG. **13** is a rear perspective view of a reclamation system including the vessel in accordance with various aspects of the present disclosure;
- (15) FIG. **14** is a front perspective view of the material deposition assembly in accordance with various aspects of the present disclosure;
- (16) FIG. **15** is a side perspective view of a dolly for moving the vessel in accordance with various aspects of the present disclosure;
- (17) FIG. **16** is a side perspective view of a carrier of the dolly in accordance with various aspects of the present disclosure;
- (18) FIG. **17** depicts an exemplary computing system for an additive manufacturing apparatus in accordance with various aspects of the present disclosure; and
- (19) FIG. **18** is a method of operating the manufacturing apparatus in accordance with various aspects of the present disclosure.
- (20) Repeat use of reference characters in the present specification and drawings is intended to represent the same or analogous features or elements of the present disclosure.

DETAILED DESCRIPTION

- (21) Reference will now be made in detail to present embodiments of the present disclosure, one or more examples of which are illustrated in the accompanying drawings. The detailed description uses numerical and letter designations to refer to features in the drawings. Like or similar designations in the drawings and description have been used to refer to like or similar parts of the present disclosure. (22) As used herein, the terms "first," "second," and "third" may be used interchangeably to distinguish one component from another and are not intended to signify a location or importance of the individual components. The terms "coupled," "fixed," "attached to," and the like refer to both direct coupling, fixing, or attaching, as well as indirect coupling, fixing, or attaching through one or more intermediate components or features, unless otherwise specified herein. The terms "upstream" and "downstream" refer to the relative direction with respect to a resin support movement along the manufacturing apparatus. For example, "upstream" refers to the direction from which the resin support moves, and "downstream" refers to the direction to which the resin support moves. The term "selectively" refers to a component's ability to operate in various states (e.g., an ON state and an OFF state) based on manual and/or automatic control of the component.
- (23) The singular forms "a," "an," and "the" include plural references unless the context clearly dictates otherwise.
- (24) Approximating language, as used herein throughout the specification and claims, is applied to modify any quantitative representation that could permissibly vary without resulting in a change in the basic function to which it is related. Accordingly, a value modified by a term or terms, such as "about," "approximately," "generally," and "substantially," is not to be limited to the precise value specified. In at least some instances, the approximating language may correspond to the precision of an instrument for measuring the value, or the precision of the methods or apparatus for constructing or manufacturing the components and/or systems. For example, the approximating language may refer to being within a ten percent margin.
- (25) Moreover, the technology of the present application will be described in relation to exemplary

- embodiments. The word "exemplary" is used herein to mean "serving as an example, instance, or illustration." Any embodiment described herein as "exemplary" is not necessarily to be construed as preferred or advantageous over other embodiments. Additionally, unless specifically identified otherwise, all embodiments described herein should be considered exemplary.
- (26) Here and throughout the specification and claims, range limitations are combined, and interchanged, such ranges are identified and include all the sub-ranges contained therein unless context or language indicates otherwise. For example, all ranges disclosed herein are inclusive of the endpoints, and the endpoints are independently combinable with each other.
- (27) As used herein, the term "and/or," when used in a list of two or more items, means that any one of the listed items can be employed by itself, or any combination of two or more of the listed items can be employed. For example, if a composition or assembly is described as containing components A, B, and/or C, the composition or assembly can contain A alone; B alone; C alone; A and B in combination; A and C in combination; B and C in combination; or A, B, and C in combination.
- (28) The present disclosure is generally directed to an additive manufacturing apparatus that implements various manufacturing processes such that successive layers of material(s) (e.g., resins) are provided on each other to "build up," layer-by-layer, a three-dimensional component. The successive layers generally cure together to form a monolithic component which may have a variety of integral sub-components. Although additive manufacturing technology is described herein as enabling the fabrication of complex objects by building objects point-by-point, layer-by-layer, variations of the described additive manufacturing apparatus and technology are possible and within the scope of the present subject matter.
- (29) The additive manufacturing apparatus can include a support plate, a window supported by the support plate, and a stage moveable relative to the window. The additive manufacturing apparatus further includes a resin support (such as a flexible tape or foil) that supports a resin. The resin support, with the resin thereon, is positioned between the stage and the window. A radiant energy device is configured to cure a portion of the resin forming the component, which is translated towards and away from the resin support by the stage between successive curing operations.
- (30) In various embodiments, the apparatus further includes a resin management system, which may include a material deposition assembly and/or a reclamation system. The material deposition assembly may be any device or combination of devices that is operable to apply a layer of the resin on the resin support. Conversely, the reclamation system may be configured to remove at least a portion of the resin that remains on the resin support after the resin support is removed from a build zone.
- (31) In some instances, the material deposition assembly includes a reservoir configured to retain a first volume of the resin and define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction. A vessel is positioned above the reservoir in a Z-axis direction and is configured to store a second volume of the resin. A conduit is configured to direct the resin from the vessel to the reservoir. The conduit may be positioned along a bottom portion of the vessel such that the resin may be gravity fed from the vessel to the conduit, which may generally prevent the introduction of air to the resin as the air is transferred into and/or through the conduit. As used herein, "gravity fed" is any system that utilizes gravity to move the resin into and/or out of a vessel or reservoir without the use of a pump or other fluid moving device.
- (32) The reclamation system may include a collection structure, such as a wiper assembly, a blade assembly, and/or any other removal assembly. The resin may be directed from the collection structure through a conduit and to a vessel. In some instances, the vessel may be positioned below the collection structure in the Z-axis direction such that the resin is gravity fed from the collection structure to the vessel through the conduit. The vessel within the material deposition assembly may have a common geometry to that within the reclamation system such that the vessels may be interchangeably used within each system. Alternatively, the vessel within the material deposition assembly may have a first geometry and the vessel within the reclamation system may have a second, different geometry.

 (33) The resin management system provided herein may allow for the resin to be moved through the apparatus while minimizing any alterations to the resin composition. Such alterations may include

aerating the composition, which may negatively impact the quality of a component built by the

apparatus.

- (34) Referring to the drawings wherein identical reference numerals denote the similar elements throughout the various views, FIG. **1** schematically illustrates an example of one type of suitable apparatus **10** for forming a component **12** created through one or more cured layers **14** of the resin R. The apparatus **10** can include one or more of a support plate **16**, a window **18**, a stage **20** that is movable relative to the window **18**, and a radiant energy device **22**, which, in combination, may be used to form any number (e.g., one or more) of additively manufactured components **12**.
- (35) In the illustrated example, the apparatus 10 includes a feed module 24, which may include a feed mandrel 24A, and a take-up module 26, which may include a take-up mandrel 26A, that are spaced-apart and configured to couple with respective end portions of a resin support 28, such as a flexible tape or foil or another type of the resin support extending therebetween. A portion of the resin support 28 can be supported from underneath by the support plate 16. Suitable mechanical supports (frames, brackets, etc.) may be provided for the mandrels 24A, 26A and the support plate 16. The feed mandrel 24A and/or the take-up mandrel 26A can be configured to control the speed and direction of the resin support 28 such that the desired tension and speed is maintained in the resin support 28 through a drive system 30. In various examples, the drive system 30 can be configured as one or more control devices 32, 34 associated with the feed mandrel 24A and/or the take-up mandrel 26A. Moreover, the drive system 30 may include various components, such as motors, actuators, feedback sensors, and/or controls can be provided for driving the mandrels 24A, 26A in such a manner to move at least a portion of the resin support 28 between the mandrels 24A, 26A.
- (36) In various embodiments, the window 18 is transparent and can be operably supported by the support plate 16. Further, the window 18 and the support plate 16 can be integrally formed such that one or more windows 18 are integrated within the support plate 16. Likewise, the resin support 28 is also transparent or includes portions that are transparent. As used herein, the terms "transparent" and "radiotransparent" refer to a material that allows at least a portion of radiant energy of a selected wavelength to pass through. For example, the radiant energy that passes through the window 18 and the resin support 28 can be in the ultraviolet spectrum, the infrared spectrum, the visible spectrum, or any other practicable radiant energy. Non-limiting examples of transparent materials include polymers, glass, and crystalline minerals, such as sapphire or quartz.
- (37) The resin support **28** extends between the feed module **24** and the take-up module **26** and defines a "resin surface" **36**, which is shown as being planar, but could alternatively be arcuate. In some instances, the resin surface **36** may be defined by a first side **38** of the resin support **28** and may be positioned to face the stage **20** with the window **18** on an opposing, second side **40** of the resin support **28** from the stage **20**. For purposes of convenient description, the resin surface **36** may be considered to be oriented parallel to an X-Y plane of the apparatus **10**, and a direction perpendicular to the X-Y plane is denoted as a Z-axis direction (X, Y, and Z being three mutually perpendicular directions). As used herein, the X-axis refers to the machine direction along the length of the resin support **28**. As used herein, the Y-axis refers to the transverse direction across the width of the resin support **28** and generally perpendicular to the machine direction. As used herein, the Z-axis refers to the stage direction that can be defined as the direction of movement of the stage **20** relative to the window **18**.
- (38) The resin surface **36** may be configured to be "non-stick," that is, resistant to adhesion of a cured resin R. The non-stick properties may be embodied by a combination of variables such as the chemistry of the resin support **28**, its surface finish, and/or applied coatings. For instance, a permanent or semi-permanent non-stick coating may be applied. One non-limiting example of a suitable coating is polytetrafluoroethylene ("PTFE"). In some examples, all or a portion of the resin surface **36** may incorporate a controlled roughness or surface texture (e.g. protrusions, dimples, grooves, ridges, etc.) with nonstick properties. Additionally or alternatively, the resin support **28** may be made in whole or in part from an oxygen-permeable material.
- (39) For reference purposes, an area or volume immediately surrounding the location of the resin support **28** and the window **18** or transparent portion defined by the support plate **16** may be defined as a "build zone," labeled **42**.
- (40) In some instances, the apparatus 10 may further include a resin management system 44, which may

include a material deposition assembly **46** and/or a reclamation system **48**. The material deposition assembly **46** may be any device or combination of devices that is operable to apply a layer of the resin R on the resin support **28**. The material deposition assembly **46** may optionally include a device or combination of devices to define a height of the resin R on the resin support **28** and/or to level the resin R on the resin support **28**. Nonlimiting examples of suitable material deposition assemblies include chutes, hoppers, pumps, spray nozzles, spray bars, or printheads (e.g. inkjets).

- (41) In the illustrated embodiment, the material deposition assembly **46** includes a vessel **50** and a reservoir **52**. A conduit **54** extends from the vessel **50** to direct resin from the vessel **50** to the reservoir **52**. The conduit **54** may be positioned along a bottom portion of the vessel **50** such that the resin R may be gravity fed from the vessel **50** to the conduit **54**, which may generally prevent the introduction of air to the resin R as the air is transferred into and/or through the conduit **54**. In some instances, a filter may be positioned upstream, downstream, and/or within the conduit with respect to the flow of resin from the vessel to the reservoir. In such instances, the resin may be gravity fed through the filter prior to entering the reservoir to catch various agglomerates, partially cured resin pieces, and/or other foreign objects that may affect the resin once it is thinned out on the resin support **28** or may affect the quality of the component **12**.
- (42) The reservoir **52** may include any assembly to control the thickness of the resin R applied to the resin support **28**, as the resin support **28** passes under and/or through the reservoir **52**. The reservoir **52** may be configured to retain a first volume of the resin R and define a thickness of the resin R on the resin support **28** as the resin support **28** is translated in an X-axis direction. The vessel **50** may be positioned above the reservoir **52** in a Z-axis direction, or in any other position, and configured to store a second volume of the resin R. In various embodiments, when the first volume of the resin R deviates from a predefined range, additional resin R is supplied from the vessel **50** to the reservoir **52**. In various non-limiting examples, the vessel **50** may be configured to retain 1 liter (L), 2 L, 5 L, 10 L, 15 L, 19 L, 20 L, 30 L, or more of resin therein and the reservoir **52** may be configured to retain 100 milliliters (mL), 150 mL, 200 mL, 250 mL, 280 mL, 300 mL or more of resin therein. Due to the variations in volume between the vessel **50** and the reservoir **52**, the material deposition assembly **46** may have a vessel volume to reservoir volume ratio of greater than 5:1, 15:1, 25:1, 35:1, 45:1, 55:1, 65:1, 67:1, or more. It will be appreciated that these ratios are generally greater than commercially available apparatuses.
- (43) In various embodiments, the vessel **50** may be operably coupled with a material deposition assembly panel **78**, which is then operably coupled with a frame on the apparatus **10**. Similarly, various components of the feed module **24** may be operably coupled with a feed panel **80** and various components of the take-up module **26** may be operably coupled with a take-up panel **82**. (44) In some embodiments, the reclamation system **48** may be configured to remove at least a portion of the resin R that remains on the resin support **28** after the resin support **28** is removed from a build
- zone **42**. For example, the reclamation system **48** may include a collection structure **238** (FIG. **13**), such as a wiper assembly, a blade assembly, and/or any other removal assembly. The resin R may be directed from the collection structure **238** through a conduit **54** and to a vessel **50**. In some instances, the vessel **50** may be positioned below the collection structure **238** in the Z-axis direction such that the resin R is gravity fed from the collection structure **238** to the vessel **50** through the conduit **54**. The vessel **50** within the material deposition assembly **46** may have a common geometry to that within the reclamation system **48** such that the vessels **50** may be interchangeably used within each system. Alternatively, the vessel **50** within the material deposition assembly **46** may have a first geometry and the vessel **50** within the reclamation system **48** may have a second, different geometry.
- (45) The resin R includes any radiant-energy curable material, which is capable of adhering or binding together the filler (if used) in the cured state. As used herein, the term "radiant-energy curable" refers to any material which solidifies or partially solidifies in response to the application of radiant energy of a particular frequency and energy level. For example, the resin R may include a photopolymer resin containing photo-initiator compounds functioning to trigger a polymerization reaction, causing the resin R to change from a liquid (or powdered) state to a solid state. Alternatively, the resin R may include a material that contains a solvent that may be evaporated out by the application of radiant energy. The

resin R may be provided in solid (e.g. granular) or liquid form, including a paste or slurry.

- (46) Furthermore, the resin R can have a relatively high viscosity fluid that will not "slump" or run off during the build process. The composition of the resin R may be selected as desired to suit a particular application. Mixtures of different compositions may be used. The resin R may be selected to have the ability to out-gas or burn off during further processing, such as a sintering process.
- (47) The resin R may incorporate a filler. The filler may be pre-mixed with the resin R, then loaded into the material deposition assembly **46**. The filler includes particles, which are conventionally defined as "a very small bit of matter." The filler may include any material that is chemically and physically compatible with the selected resin R. The particles may be regular or irregular in shape, may be uniform or non-uniform in size, and may have variable aspect ratios. For example, the particles may take the form of powder, of small spheres or granules, or may be shaped like small rods or fibers.
- (48) The composition of the filler, including its chemistry and microstructure, may be selected as desired to suit a particular application. For example, the filler may be metallic, ceramic, polymeric, and/or organic. Other examples of potential fillers include diamond, silicon, and graphite. Mixtures of different compositions may be used. In some examples, the filler composition may be selected for its electrical or electromagnetic properties, e.g. it may specifically be an electrical insulator, a dielectric material, an electrical conductor, and/or magnetic.
- (49) The filler may be "fusible," meaning it is capable of consolidation into a mass upon via application of sufficient energy. For example, fusibility is a characteristic of many available powders including, but not limited to, polymeric, ceramic, glass, and/or metallic materials. The proportion of filler to resin R may be selected to suit a particular application. Generally, any amount of filler may be used so long as the combined material is capable of flowing and being leveled, and there is sufficient resin R to hold together the particles of the filler in the cured state.
- (50) With further reference to FIG. **1**, the stage **20** is capable of being oriented parallel to the resin surface **36** or the X-Y plane. Various devices may be provided for moving the stage **20** relative to the window **18** parallel to the Z-axis direction. For example, as illustrated in FIG. **1**, the movement may be provided through an actuator **56** connected between the stage **20** and a static support **58** and configured to change a relative position of the stage **20** relative to the radiant energy device **22**, the support plate **16**, the window **18**, and/or any other static component of the apparatus **10**. The actuator **56** may be configured as a ballscrew electric actuator, linear electric actuator, pneumatic cylinder, hydraulic cylinder, delta drive, or any other practicable device may additionally or alternatively be used for this purpose. In addition to, or as an alternative to, making the stage **20** movable, the resin support **28** could be movable parallel to the Z-axis direction.
- (51) The radiant energy device 22 may be configured as any device or combination of devices operable to generate and project radiant energy on the resin R in a suitable pattern and with a suitable energy level and other operating characteristics to cure the resin R during the build process. For example, as shown in FIG. 1, the radiant energy device 22 may include a projector 60, which may generally refer to any device operable to generate a radiant energy patterned image of suitable energy level and other operating characteristics to cure the resin R. As used herein, the term "patterned image" refers to a projection of radiant energy comprising an array of one or more individual pixels. Non-limiting examples of patterned imaged devices include a DLP projector or another digital micromirror device, a two-dimensional array of LEDs, a two-dimensional array of lasers, and/or optically addressed light valves. In the illustrated example, the projector 60 includes a radiant energy source 62 such as a UV lamp, an image forming apparatus 64 operable to receive a source beam 66 from the radiant energy source 62 and generate a patterned image 68 to be projected onto the surface of the resin R, and optionally focusing optics 70, such as one or more lenses.
- (52) The image forming apparatus **64** may include one or more mirrors, prisms, and/or lenses and is provided with suitable actuators, and arranged so that the source beam **66** from the radiant energy source **62** can be transformed into a pixelated image in an X-Y plane coincident with the surface of the resin R. In the illustrated example, the image forming apparatus **64** may be a digital micro-mirror device.
- (53) The projector **60** may incorporate additional components, such as actuators, mirrors, etc.

- configured to selectively move the image forming apparatus **64** or another part of the projector **60** with the effect of rastering or shifting the location of the patterned image on the resin surface **36**. Stated another way, the patterned image may be moved away from a nominal or starting location. (54) In addition to other types of radiant energy devices **22**, the radiant energy device **22** may include a
- "scanned beam apparatus" used herein to refer generally to any device operable to generate a radiant energy beam of suitable energy level and other operating characteristics to cure the resin R and to scan the beam over the surface of the resin R in a desired pattern. For example, the scanned beam apparatus can include a radiant energy source **62** and a beam steering apparatus. The radiant energy source **62** may include any device operable to generate a beam of suitable power and other operating characteristics to cure the resin R. Non-limiting examples of suitable radiant energy sources **62** include lasers or electron beam guns.
- (55) The apparatus **10** may be operably coupled with a computing system **72**. The computing system **72** in FIG. **1** is a generalized representation of the hardware and software that may be implemented to control the operation of the apparatus **10**, including some or all of the stage **20**, the radiant energy device **22**, the actuator **56**, and the various parts of the apparatus **10** described herein. The computing system **72** may be embodied, for example, by software running on one or more processors embodied in one or more devices such as a programmable logic controller ("PLC") or a microcomputer. Such processors may be coupled to process sensors and operating components, for example, through wired or wireless connections. The same processor or processors may be used to retrieve and analyze sensor data, for statistical analysis, and for feedback control. Numerous aspects of the apparatus **10** may be subject to closed-loop control.
- (56) Optionally, the components of the apparatus **10** may be surrounded by a housing **74**, which may be used to provide a shielding or inert gas (e.g., a "process gas") atmosphere using gas ports **76**. Optionally, pressure within the housing **74** could be maintained at a desired level greater than or less than atmospheric. Optionally, the housing **74** could be temperature and/or humidity controlled. Optionally, ventilation of the housing **74** could be controlled based on factors such as a time interval, temperature, humidity, and/or chemical species concentration. In some embodiments, the housing **74** can be maintained at a pressure that is different than an atmospheric pressure.
- (57) Referring to FIGS. 2 and 3, exemplary perspective views of the feed module 24 including a feed panel 80 are illustrated in accordance with exemplary embodiments of the present disclosure. As illustrated, the feed mandrel 24A can be anchored to the feed panel 80 and may support and rotate a feed portion 84 (FIG. 1) of the resin support 28 (FIG. 1). In various embodiments, the feed mandrel 24A includes a front portion 86 on a first side 88 of the feed panel 80 and a rear portion 90 on a second, opposing side 92 of the feed panel 80. In some instances, a bearing 94 may be positioned along the front portion 86, the rear portion 90, and/or between the front and rear portions 86, 90.
- (58) The front portion **86** of the feed mandrel **24**A may include a cylindrical portion **96** that is configured to accept the first portion **84** of the resin support **28** thereabout. In various instances, the resin support **28** may be operably coupled to a feed spool (e.g., cardboard spool, polymeric spool, paper-based spool, metallic spool, composite spool, elastomeric spool, etc.). The feed spool may be positioned about the feed mandrel **24**A.
- (59) A stop **98** may be positioned between the cylindrical portion **96** and the feed panel **80**. As such, when the resin support **28** is wrapped about the feed mandrel **24**A, the stop **98** defines a first distance d **1** between an inner edge of the resin support **28** and the feed panel **80**. In some examples, the feed mandrel **24**A may be configured to move between a disengaged position and an engaged position. In operation, the feed mandrel **24**A may be placed in the disengaged position to allow the feed spool, and the resin support **28** wound thereabout, to be slid along the feed mandrel **24**A to a position in which an end portion of the feed spool is in contact or close proximity to the stop **98**. Once the feed spool is positioned about the feed mandrel **24**A, the feed mandrel **24**A may be placed in the engaged position causing the feed spool, and, consequently, the feed portion **84** of the resin support **28** to rotate with the feed mandrel **24**A.
- (60) In some embodiments, the drive system **30** (FIG. **1**) may include a first control device **32** operably coupled with the rear portion **90** of the feed mandrel **24**A. The first control device **32** may be

- configured as one or more motors, actuators, or any other device that may rotate the feed mandrel **24**A. Further, as illustrated in FIG. **3**, the first control device **32** may include a transmission **100** in the form of a belt system, a gear system, and/or any other practicable system.
- (61) With further reference to FIGS. 2 and 3, one or more rollers 102A, 102B and/or a load cell 104 may be anchored to the first side 88 of the feed panel 80. For example, a pair of rollers 102A, 102B may be positioned above the feed mandrel 24A in the Z-axis direction. In some instances, the pair of rollers 102A, 102B may have an axis of rotation 106 that is generally parallel to an axis of rotation 108 of the feed mandrel 24A.
- (62) The load cell **104** may be positioned between the pair of rollers **102**A, **102**B and the feed mandrel **24**A in the Z-axis direction. The load cell **104** may be configured as a force transducer that converts a tension or torque provided by the resin support **28** onto the load cell **104** into an electrical signal that can be measured by the computing system **72** to determine a tension of the resin support **28**. In some embodiments, the resin support **28** may be provided from the feed mandrel **24**A around the first roller **102**A, the load cell **104**, and, subsequently, the second roller **102**B.
- (63) Referring to FIGS. **4** and **5**, respective front and rear perspective views of the take-up module **26** including a take-up panel **82** are illustrated in accordance with exemplary embodiments of the present disclosure. As illustrated, the take-up mandrel **26**A may be anchored to the take-up panel **82** and configured to support a second portion **110** (FIG. **1**) of the resin support **28** (FIG. **1**). In various embodiments, the take-up mandrel **26**A includes a front portion **112** on a first side **114** of the take-up panel **82** and a rear portion **116** on a second, opposing side **118** of the take-up panel **82**. In some instances, a bearing **120** may be positioned along the front portion **112**, the rear portion **116**, and/or between the first and second portions **112**, **116** of the take-up mandrel **26**A.
- (64) The front portion **112** of the take-up mandrel **26**A may include a cylindrical portion **122** that is configured to accept the second portion **110** of the resin support **28** thereabout. In various instances, the resin support **28** may be operably coupled to a take-up spool (e.g., cardboard spool, polymeric spool, paper-based spool, metallic spool, composite spool, elastomeric spool, etc.). The take-up spool may be positioned about the take-up mandrel **26**A.
- (65) A stop **124** may be positioned between the cylindrical portion **122** and the take-up panel **82**. As such, the resin support **28** is wrapped about the take-up mandrel **26**A, the stop **124** defines a second distance d **2** between the inner edge of the resin support **28** and the take-up panel **82**. In some examples, the take-up mandrel **26**A may be configured to move between a disengaged position and an engaged position. In operation, the take-up mandrel **26**A may be placed in the disengaged position to allow the take-up spool to be slid along the take-up mandrel **26**A to a position in which an end portion of the take-up spool is in contact or close proximity to the stop **124**. Once the take-up spool is positioned about the take-up mandrel **26**A, the take-up mandrel **26**A may be placed in the engaged position causing the take-up spool, and, consequently, the second portion **110** of the resin support **28** to rotate with the take-up mandrel **26**A.
- (66) Similar to the feed module **24**, a second control device **34** may be operably coupled with the rear portion **116** of the take-up mandrel **26**A. The second control device **34** may be configured as one or more motors, actuators, or any other device that may rotate the take-up mandrel **26**A. Further, as illustrated in FIG. **5**, the second control device **34** may include a transmission **126** in the form of a belt system, a gear system, and/or any other practicable system. Moreover, the first control device **32** and the second control device **34** may be operably coupled with feedback sensors and/or controls that can be provided for driving the mandrels **24**A, **26**A in such a manner to maintain the resin support **28** tensioned between the mandrels **24**A, **26**A and to wind the resin support **28** from the feed mandrel **24**A to the take-up mandrel **26**A.
- (67) With further reference to FIGS. **4** and **5**, one or more rollers **128** may be anchored to the first side **114** of the take-up panel **82**. For example, a set of three rollers **128**A, **128**B, **128**C may be positioned on various portions of the take-up panel **82**. In some instances, each roller **128**A, **128**B, **128**C may have an axis of rotation **130** that is generally parallel to an axis of rotation **132** of the take-up mandrel **26**A. (68) The take-up panel **82** may further support the resin reclamation system **48**, which may be configured to remove at least a portion of the resin R that remains on the resin support **28** after the resin

support **28** is removed from a build zone **42** (FIG. **1**).

- (69) Referring now to FIG. **6**, the material deposition assembly **46** is schematically illustrated according to various embodiments of the present disclosure. As illustrated, the material deposition assembly **46** includes a vessel **50** and a reservoir **52**. A conduit **54** extends from the vessel **50** to direct resin R from the vessel **50** to the reservoir **52**. The conduit **54** may be positioned along a bottom portion of the vessel **50** such that the resin R may be gravity fed from the vessel **50** to the conduit **54**, which may generally prevent the introduction of air to the resin R as the air is transferred into and/or through the conduit **54**. (70) The reservoir **52** may be configured to retain a first volume **136** of the resin R and produce a layer of the resin R on the resin support **28** as the resin support **28** is translated in an X-axis direction. The vessel **50** may be positioned above the reservoir **52** in a Z-axis direction, or in any other position, and configured to store a second volume **138** of the resin R. In various embodiments, when the first volume **136** of the resin R deviates from a predefined range, additional resin R is supplied from the vessel **50** to the reservoir **52**.
- (71) In some embodiments, the reservoir **52** includes a base **134**, an upstream wall **142**, a downstream wall **144**, and sidewalls **146**. The upstream wall **142** may define a slot **148** therein to receive the resin support **28**. The downstream wall **144** may define an aperture **150** that serves as an outlet for the resin support **28** and the layer **140** of the resin R. In various embodiments, the upstream wall **142**, the downstream wall **144**, and the sidewalls **146** define a cavity **152** that is configured to retain the first volume **136** of the resin R, which may be supplied by the conduit **54**.
- (72) Continuing to refer to FIG. **6**, in various examples, the material deposition assembly **46** can include a first doctor blade **154** and/or a second doctor blade **156** that are used to control the thickness of the resin R applied to the resin support **28**, as the resin support **28** passes under the material deposition assembly **46**. In the illustrated embodiment, the thickness of layer **140** is determined by the doctor blades **154**, **156**. In various embodiments, other material depositing apparatuses can be used separately or in combination with the first and second doctor blades **154**, **156** such as, but not limited to, gravure rolls, metering rolls, weir-based cascades, direct die casting, and a combination thereof.
- (73) The first doctor blade **154** may be configured to act as a gross control for the thickness **158** of an initial deposited layer **160** of the resin R. An adjustment device **162** may be configured to adjust an angle **164** defined by a surface of the first doctor blade **154** and the top edge of the sidewall **146**. The greater the angle **164**, the lower thickness **158**, i.e., the thinner initial deposited layer **160** will be. The adjustment device **162** can be a threaded screw assembly configured to extend and retract the order to affect change in the angle **164**. The adjustment device **162** is mechanically linked to the first doctor blade **154**.
- (74) The second doctor blade **156** can be movingly linked to the downstream wall **144** and can be moved by an actuator **166** to adjust and define the outlet gap. A control signal can be utilized to controllably connect the actuator **166** with the computing system **72**. The layer **140** has a thickness **168** that is the distance between the surface of the resin R and the base of layer **140** which is in contact with the first surface of the resin support **28**. Accordingly, the thickness **168** of the material layer **140** can be adjusted by a control action such as movement of the doctor blade **154** in response to signals from the computing system **72**. In various embodiments, suitable control signals can be electrical, pneumatic, sonic, electromagnetic, a combination thereof, and/or any other type of signal. In addition, other suitable control actions include varying the speed of the resin support **28**, adjusting the viscosity or other rheological property of the resin R, changing the width of the deposited material layer **140** such as by the repositioning of side dams.
- (75) Continuing to refer to a FIG. **6**, a thickness sensor **170** is positioned downstream of the second doctor blade **156** and/or the downstream wall **144**. The thickness sensor **170** is configured to determine a thickness **168** of the deposited material layer **140**. As a result, the deposited material layer **140** has the thickness **168** as it passes from the material deposition assembly **46** into and through a build zone **42** as shown in FIG. **1**. As represented in FIG. **6**, the thickness sensor **170** is configured to generate monitoring signals indicative of the thickness **168** of the deposited material layer **140** and to transmit such signals to the computing system **72**. The thickness sensor **170** may be embodied as one or more confocals, imaging sensor, or any other vision-based device. The thickness sensor **170** may additionally

and/or alternatively be configured as any other practicable proximity sensor, such as, but not limited to, an ultrasonic sensor, a radar sensor, a LIDAR sensor, or the like.

- (76) The computing system **72** is configured to receive the monitoring signals and process such signals using predetermined algorithms to generate control signals for controlling the thickness of the deposited material layer **140**. In this manner, closed loop control of the thickness **168** of the deposited material layer **140** can be achieved. Optionally, when the sensor indicates that the layer **140** is too thin additional resin R can be added to increase the thickness of the layer **140**.
- (77) Still referring to FIG. 6, in several embodiments, the material deposition assembly 46 further includes a regulator **174** operably coupled with the conduit **54**. The regulator **174** is configured to restrict flow of the resin R from the vessel **50** to the reservoir **52** in a first position and allow flow from the vessel **50** to the reservoir **52** in a second position. In some embodiments, the regulator **174** may be configured as a pneumatically actuated pinch valve. In various embodiments, suitable control of the regulator **174** can be accomplished through activation of an electrical device, a pneumatic device, a sonic device, an electromagnetic device, a combination thereof, and/or any other practicable device. (78) In various embodiments, the material deposition assembly **46** can further include a volume sensor **176**. The volume sensor **176** can be configured to provide signals to the computing system **72** related to the first volume **136** of the resin R within the cavity **152** of the reservoir **52**. The computing system **72** is configured to receive the monitoring signals and process such signals using predetermined algorithms to generate control signals for controlling the regulator **174**. For instance, the computing system **72** can actuate the regulator **174** from the second position to the first position when the first volume **136** of the resin R is within a predefined range. In this manner, closed-loop control of the first volume **136** of the resin R can be achieved. Once the first volume **136** of the resin R returns to the predefined range, the computing system **72** can actuate the regulator **174** from the first position to the second position thereby blocking further flow of the resin R from the vessel **50** to the reservoir **52**. The volume sensor **176** may be embodied as one or more imaging sensors or any other vision-based device. The volume sensor **176** may additionally and/or alternatively be configured as any other practicable proximity sensor, such as, but not limited to, an ultrasonic sensor, a radar sensor, a LIDAR sensor, or the like.
- (79) In some embodiments, the actuation of the regulator **174** may additionally or alternatively be based on any other input. For example, the volume of the resin R transferred from the vessel **50** to the reservoir **52** may be at least partially based on data provided by the thickness sensor **170**, the volume of resin support **28** translated through the reservoir **52**, and/or any other information.
- (80) In some examples, a restrictor **178** may also be operably coupled with the conduit **54** and configured to block flow of the resin R past the restrictor **178** when placed in a restricted position. Conversely, when placed in a flow position, the restrictor **178** may allow the resin R to flow past the restrictor **178**. In some examples, the restrictor **178** may be manually moved between the blocked position and the flow position through a handle **180**. However, the restrictor **178** may be moved between positions in any other manner without departing from the scope of the present disclosure. (81) In some instances, the restrictor **178** may be moved to the blocked position prior to the vessel **50** being removed from the apparatus **10**. When the vessel **50** and/or a new vessel **50** is to be installed in the apparatus **10**, the restrictor **178** may be maintained in the blocked position. Next, the conduit **54** may be operably coupled with the regulator **174**. Once the conduit **54** is coupled with the regulator **174**.
- the resin R during installation and removal of the vessels **50** from the apparatus **10**. (82) With further reference to FIG. **6**, in various embodiments, a brace **182** may be operably coupled with a frame of the manufacturing apparatus **10**. For example, the brace **182** may be operably coupled with the material deposition assembly panel **78**. In some instances, the brace **182** may extend from the material deposition assembly panel **78** in the Y-axis direction. Further, the brace **182** may define one or more support surfaces **184** that is configured to support and/or otherwise retain the vessel **50** in a

the restrictor **178** may be placed in the flow position. As such, the restrictor **178** may be used to control

(83) As illustrated, in some examples, the vessel **50** may include one or more brackets **186** coupled thereto. For example, first and second brackets **186** may be operably coupled with opposite sides of the vessel **50**. The one or more brackets **186** may be configured to retain the vessel **50** in a predefined

predefined location.

- location. In various embodiments, the one or more brackets **186** may include an upper portion **188**, a lower portion **190**, and a body portion **192** extending between the upper portion **188** and the lower portion **190**. In some examples, the one or more brackets **186** may be retained or operably coupled with the braces **182**. For instance, the lower portion **190** of the bracket **186**, and/or any other portion of the bracket **186**, may be positioned at least partially on the support surface **184**.
- (84) In several embodiments, the brace **182** may include a brace locating pin **194** that extends from the support surface **184**. The support pin may be integrally formed with the brace **182** and/or later attached thereto. The lower portion **190** of the bracket **186** may define a first locating void **196** that is sized to surround the brace locating pin **194** when the lower portion **190** of the bracket **186** is supported by the brace **182**.
- (85) With further reference to FIG. **6**, in some instances, a mixing assembly **198** may be configured to continuously and/or intermittently agitate the resin R within the vessel **50** to increase the consistency and quality of the resin R. As illustrated, in some embodiments, the mixing assembly **198** may include a housing **200** positioned above the vessel **50**. The housing **200** supports a rotation assembly **202** capable of rotating an impeller **204** within the vessel **50**. The rotation assembly **202** may be configured as a direct drive system that includes one or more motors, actuators, or any other device that may rotate the impeller **204**. Alternatively, the rotation assembly **202** may be configured as an offset drive system in which the rotation assembly **202** is operably coupled with the impeller **204** through a transmission. (86) In various embodiments, the mixing assembly may be configured to rotate the impeller **204** at one or more speeds. In some instances, the impeller **204** may be rotated as a first speed (e.g., 0.01 to 40 rpm), which may be sufficient to generally prevent segregation and decrease the possibility of trapping air (aerating the slurry). In addition, the impeller **204** may be rotated at a second, faster speed (e.g., greater than 40 rpm), which may allow for the breaking up of agglomerates by providing more shear force to the resin R.
- (87) In various embodiments, the impeller **204** may be made from a wide array of materials, including, but not limited to, polymers, which may allow for the resin R to burn off in a sintering cycle, metals, which may provide wear resistance, ceramics (e.g. alumina coated), which may further increase wear resistance, and/or any other practicable material. In some embodiments, the impeller material may be matched to and/or compatible with the resin R being used in the manufacturing process as some resins R will be more abrasive and others will be less. Moreover, the impeller **204** may be cleanable (with solvents e.g. isopropyl alcohol, acetone, etc.) and the material of the impeller **204** may be based on the ability to clean the resin R from the impeller **204**.
- (88) In the exemplary embodiment illustrated in FIG. **6**, the impeller **204** is configured as a double-helix impeller. However, it will be appreciated that the impeller **204** may be of any design without departing from the scope of the present disclosure. For example, as illustrated in FIG. **9**, the impeller **204** may be a pitched blade impeller. In embodiments utilizing a double-helix impeller, such as the one illustrated in FIG. **6**, the impeller **204** may be used to blend high viscosity resins R operating in a laminar flow regime. The helical ribbons of the impeller **204** may also be designed for close wall clearance. Furthermore, the helical ribbons operate at relatively slow speeds rotating in a direction to create resin movement up along the wall. The resin R returns down the center of the vessel **50** providing overall blending in the vessel **50**.
- (89) Referring to FIGS. **6-8**, various views of the material deposition assembly **46** are exemplary illustrated in accordance with aspects of the present disclosure. As provided herein, the rotation assembly **202** is operably coupled with the impeller **204**. In various embodiments, the material deposition assembly panel **78** may define a channel **208** and at least a portion of the rotation assembly **202** may extend through the channel **208** and to a position over the vessel **50**. The rotation assembly **202** may include a coupler **210** that allows for the impeller **204** to be selectively coupled thereto. (90) In some embodiments, the rotation assembly **202** may be movable within the channel **208** generally in the Z-axis direction. In some examples, the rotation assembly **202** may be operably coupled with a track assembly **212** to guide movement in the Z-axis. As illustrated, the track assembly **212** may be operably coupled with a rear side of the material deposition assembly panel **78**, and/or any other component of the apparatus **10**.

- (91) In the illustrated embodiment, the track assembly **212** includes first and second rails **214**, **216** positioned on opposing sides of the channel **208** of the material deposition assembly panel **78**. The rotation assembly **202** includes guides **218** coupled with each of the first and second rails **214**, **216**. The guides **218** are configured to slide along each of the first and second rails **214**, **216**. In some examples, the track assembly **212** may include one or more retainers that are configured to retain the rotation assembly **202** in predefined positions along the first and second rails **214**, **216**.
- (92) Additionally or alternatively, in some instances, a movement device **220** may be operably coupled with rotation assembly **202** and configured to move the rotation assembly **202** along the track assembly **212** and/or retain the rotation assembly **202** in a position along the track assembly **212**. For example, the movement device **220** provides upward vertical force through hydraulics, pneumatics, spring mechanics, actuator, and/or otherwise.
- (93) In some examples, the movement device **220** may include a pneumatic linear actuator that includes a body, a piston, and a slide or carriage that is operably coupled with the piston and the rotation assembly **202**. The piston is moved by a fluid sent into a chamber that is present on both ends of the piston.
- (94) First and second valves may be fluidly coupled with the chamber that allows for fluid to be selectively provided to either side of the piston causing the piston to move in response. The movement of the piston also causes the slide to move, which, in turn, moves the rotation assembly **202**. The first and second valves can also have flow control features to be able to adjust the speed at which the rotation assembly **202** is moved along the first and second rails **214**, **216**.
- (95) With further reference to FIG. **8**, in some embodiments, an access may be positioned above the material deposition assembly **46** in the Z-axis direction. For example, the access may be a pane **222** that allows visibility of the vessel **50**. The pane **222** may be configured to block UV light, and/or any other spectrum of light, from being able to pass therethrough. Furthermore, in various embodiments, the pane **222** may be moveable such that the material deposition assembly **46** may be accessible through the pane **222**.
- (96) Referring now to FIGS. **9-12**, views of a material deposition system in accordance with various aspects of the present disclosure are provided. In certain exemplary embodiments, the material deposition device may have various components that are configured in a generally common manner with the exemplary material deposition assembly **46** described above with reference to FIGS. **1-8**. Accordingly, the same or similar numbers may refer to the same or similar parts.
- (97) In some embodiments, such as those illustrated in FIGS. **9-12**, the vessel **50** may be offset from the reservoir **52** in the X-axis direction. As such, the conduit **54** extending between the vessel **50** and the reservoir **52** may be non-linear in the Z-axis direction. In various embodiments, a connector **224** may be operably coupled with the reservoir **52** to maintain the conduit **54** in a predefined orientation. The connector **224** may be integrally formed with the reservoir **52** and/or operably coupled therewith. The connector **224** may be configured to direct an end portion of the conduit **54** towards the cavity **152** of the reservoir **52**.
- (98) With further reference to FIGS. **9-12**, the regulator **174** may be coupled with the conduit **54**. As provided herein, the regulator **174** is configured to restrict flow of the resin R from the vessel **50** to the reservoir **52** in a first position and allow flow from the vessel **50** to the reservoir **52** in a second position. In some embodiments, the regulator **174** may be configured as a pneumatically actuated pinch valve. In various embodiments, suitable control of the regulator **174** can be accomplished through activation of an electrical device, a pneumatic device, a sonic device, an electromagnetic device, a combination thereof, and/or any other practicable device.
- (99) As discussed above, the material deposition assembly **46** can further include a volume sensor **176**. The volume sensor **176** can be configured to provide signals to the computing system **72** related to the first volume **136** of the resin R within the cavity **152** of the reservoir **52**. The computing system **72** is configured to receive the monitoring signals and process such signals using predetermined algorithms to generate control signals for controlling the regulator **174**. For instance, the computing system **72** can actuate the regulator **174** from the second position to the first position when the first volume **136** of the resin R is within a predefined range. In this manner, closed-loop control of the first volume **136** of the

resin R can be achieved. Once the first volume **136** of the resin R returns to the predefined range, the computing system **72** can actuate the regulator **174** from the first position to the second position thereby blocking further flow of the resin R from the vessel **50** to the reservoir **52**. The volume sensor **176** may be embodied as one or more imaging sensors or any other vision-based device. The volume sensor **176** may additionally and/or alternatively be configured as any other practicable proximity sensor, such as, but not limited to, an ultrasonic sensor, a radar sensor, a LIDAR sensor, or the like.

- (100) In some embodiments, the actuation of the regulator **174** may additionally or alternatively be based on any other input. For example, the volume of the resin R transferred from the vessel **50** to the reservoir **52** may be at least partially based on the thickness sensor **170**, the volume of resin support **28** translated through the reservoir **52**, and/or any other information.
- (101) In some examples, the restrictor **178** may also be operably coupled with the conduit **54** and configured to block flow of the resin R past the restrictor **178** when placed in a restricted position. Conversely, when placed in a flow position, the restrictor **178** may allow the resin R to flow past the restrictor **178**. In some examples, the restrictor **178** may be manually moved between the blocked position and the flow position through a handle **180**. However, the restrictor **178** may be moved between positions in any other manner without departing from the scope of the present disclosure. (102) With further reference to FIGS. 9-12, the rotation assembly 202 may include a transmission 226 in the form of a belt system but may also be configured as any other practicable system. In some cases, the transmission **226** may be operably coupled with a transmission plate **228**. In some instances, a first pulley **230** may be operably coupled the transmission plate **228** and an actuator **232**. A second pully **234** may be coupled with the impeller **204**. A belt **236** or other energy transferring device may be positioned about the first and second pulleys **230**, **234** to transfer energy from the actuator **232** to the impeller **204**. (103) In some instances, a housing **200** may at least partially surround the transmission **226** plate and/or the movement device **220**. In addition, the housing **200** (or the transmission plate **228**) may be operably coupled with the track assembly 212 to allow for movement of the transmission plate 228 along the Zaxis direction. Additionally, in some instances, a movement device **220** may be operably coupled with rotation assembly 202 and configured to move the rotation assembly 202 along the track assembly 212 and/or maintain the rotation assembly **202** in a position along the track assembly **212**. For example, the movement device **220** provides upward vertical force through hydraulics, pneumatics, spring mechanics, actuator, and/or otherwise.
- (104) With further reference to FIGS. 9-12, in some embodiments, the impeller 204 may be configured as a pitched, or double-pitched, blade impeller. Moreover, the impeller 204 may include any number of blades. For example, as illustrated, the impeller 204 may include three blades. The pitched impellers may induce a top-to-bottom turnover of the resin R and circulate the resin R without excessive swirling. (105) Referring now to FIG. 13, a view of a reclamation system 48 within the resin management system 44 in accordance with various aspects of the present disclosure is provided. In certain exemplary embodiments, the reclamation system 48 may be configured to include various components that are generally common with the exemplary material deposition assemblies described above with reference to FIGS. 1 through 12. Accordingly, the same or similar numbers may refer to the same or similar parts. (106) In some embodiments, the reclamation system 48 may include a collection structure 238 that is configured to remove at least a portion of the resin R from the resin support 28. As the resin R is removed by the collection structure 238, the resin R is directed through a conduit 54 and into a vessel 50. In some examples, the collection structure 238 is supported by and positioned on a first side 114 of the take-up panel 102 and the vessel 50 is positioned on an opposing second side 118 of the take-up panel 102.
- (107) With further reference to FIGS. **13** and **14**, the vessel **50** may be suspended by a reinforcement and/or a brace **182**. In some instances, a mixing assembly **198** may be configured to continuously and/or intermittently agitate the resin R within the vessel **50** to generally maintain the consistency and quality of the resin R. As illustrated, in some embodiments, the mixing assembly **198** may include a housing **200** operably coupled with the reinforcement. The housing **200** supports a rotation assembly **202** capable of rotating an impeller **204** that extends into the vessel **50**. The mixing assembly **198** may allow for the resin R to be continually agitated to prevent excessive settling or separation of the resin R.

- (108) As discussed above, the vessel **50** may include a bracket **186** that is operably coupled with the brace **182** to maintain the vessel **50** in a predefined location. The bracket **186** may be of any practicable geometry. In some embodiments, such as the one illustrated in FIG. **13**, the bracket **186** may include an upper portion **188**, a lower portion **190**, and a body portion **192** extending between the upper portion **188** and the lower portion **190**.
- (109) In some instances, the brace **182** may include a brace locating pin **194**. The lower portion **190** of the bracket **186** may include a first locating void **196** that is configured to at least partially surround the brace locating pin **194**. As such, the bucket may be placed in a generally consistent location within the reclamation system **48**.
- (110) In the illustrated embodiment, the reclamation system **48** may also include a track assembly **212**. The housing **200** can include guides **218** coupled with each of the rails **214**. The guides **218** are configured to slide along each of the rails **214**. In some examples, the track assembly **212** may include one or more retainers that are configured to retain the rotation assembly **202** in predefined positions along the rails **214**. Additionally or alternatively, in some instances, a movement device **220** may be operably coupled with rotation assembly **202** and configured to move the rotation assembly **202** along the track assembly **212** and/or maintain the rotation assembly **202** in a position along the track assembly **212**. For example, the movement device **220** provides upward vertical force through hydraulics, pneumatics, spring mechanics, actuator, and/or otherwise.
- (111) Referring now to FIGS. **14-16**, in some instances, the bracket **186** of vessel **50** of the material deposition assembly **46** and the bracket **186** of the vessel **50** of the reclamation system **48** may be generally of the same configuration. For example, as provided herein, the lower portion **190** of each bracket **186** may include a first locating void **196** that is configured to at least partially surround a brace locating pin **194** of the brace **182** within the material deposition assembly **46** and/or the reclamation system **48**. In addition, each of the upper portions **188** of the brackets **186** may also define a second locating void **240**. The second locating voids **240** of the upper portions **188** may be of a similar size or geometry to that of the first locating voids **196** of the lower portions **190**. Alternatively, the second locating voids **240** of the upper portions **188** may be of a different size or geometry to that of the lower portions **190**.
- (112) Referring still to FIGS. **14-16**, in various embodiments, due to a common geometry of the bracket **186** of the vessel **50** of the material deposition assembly **46** and the bracket **186** of the vessel **50** of the reclamation system **48**, a common dolly **244** may be used to place the vessels **50** within and/or remove the vessels **50** from the apparatus **10** (FIG. **1**). For example, the dolly **244** may include a base portion **246** that includes one or more movement assemblies **248**, such as wheels, rollers, and the like. A beam **250** may extend from the base portion **246**. The beam **250** may include a slide assembly **252** that allows for a carrier **254** to slide along the beam **250**. In some examples, the slide assembly **252** may include one or more retainers that are configured to retain the carrier **254** in predefined positions along the slide assembly **252**.
- (113) Additionally or alternatively, in some instances, a movement device **256** may be operably coupled with the carrier **254** and configured to move the carrier **254** along the slide assembly **252** and/or maintain the carrier **254** in a position along the slide assembly **252**. For example, the movement device **256** provides upward vertical force through an actuator (e.g., electric) hydraulics, pneumatics, spring mechanics, and/or otherwise.
- (114) In various embodiments, the dolly **244** may further include an input device **258** for altering the position of the carrier **254** along the slide assembly **252**. For example, as illustrated in FIGS. **15** and **16**, the input device **258** may be in the form of a lever that allows for selective movement of the carrier **254**. (115) Referring back to FIGS. **14-16**, in several embodiments, the carrier **254** includes a pair of arms **260**. Each of the arms **260** may be of a height h, that is less than a height hi, defined between the upper portion **188** and the lower portion **190** of each bracket **186**. As such, the arms **260** may be slid between the upper portion **188** and the lower portion **190** of each bracket **186**. Furthermore, the first arm **260** of the carrier **254** may be separated from the second arm **260** of the carrier **254** by a width that is greater than the width defined by the vessel **50** and the opposing body portions **192** of the brackets **186** installed on a common vessel **50**. Thus, in some embodiments, the carrier **254** may be positioned within

the channels defined by the brackets **186** on the opposing sides of the vessel **50**. To make insertion of the first and second arms **260** into the respective channels of the brackets **186**, the an outer end portion of each arm **260** may be chamfered.

(116) In several embodiments, each arm **260** may also define a carrier locating pin **262** on an upper surface thereof. The carrier locating pin **262** on each arm **260** may be surrounded by the second locating void **240** on the upper portion **188** of each bracket **186**. As such, the first locating void **196** within the lower portion **190** of each bracket **186** may surround a brace carrier locating pin **262** when installed within the apparatus **10** and the second locating void **240** of the upper portion **188** of each bracket **186** may surround a carrier locating pin 262 on the carrier 254 when transported by the dolly 244. (117) FIG. **17** depicts certain components of the computing system **72** according to example embodiments of the present disclosure. The computing system 72 can include one or more computing device(s) **72**A which may be used to implement the method **300** such as described herein. The computing device(s) 72A can include one or more processor(s) 72B and one or more memory device(s) 72C. The one or more processor(s) 72B can include any suitable processing device, such as a microprocessor, microcontroller, integrated circuit, an application specific integrated circuit (ASIC), a digital signal processor (DSP), a field-programmable gate array (FPGA), logic device, one or more central processing units (CPUs), graphics processing units (GPUs) (e.g., dedicated to efficiently rendering images), processing units performing other specialized calculations, etc. The memory device(s) 72C can include one or more non-transitory computer-readable storage medium(s), such as RAM, ROM, EEPROM, EPROM, flash memory devices, magnetic disks, etc., and/or combinations

- (118) The memory device(s) **72**C can include one or more computer-readable media and can store information accessible by the one or more processor(s) **72**B, including instructions **72**D that can be executed by the one or more processor(s) **72**B. The instructions **72**D may include one or more steps of the method **300** described herein, such as to execute operations of the additive manufacturing apparatus **10** described above. For instance, the memory device(s) **72**C can store instructions **72**D for running one or more software applications, displaying a user interface, receiving user input, processing user input, etc. In some implementations, the instructions **72**D can be executed by the one or more processor(s) **72**B to cause the one or more processor(s) **72**B to perform operations, e.g., such as one or more portions of methods described herein. The instructions **72**D can be software written in any suitable programming language or can be implemented in hardware. Additionally, and/or alternatively, the instructions **72**D can be executed in logically and/or virtually separate threads on processor(s) **72**B.
- (119) The one or more memory device(s) **72**C can also store data **72**E that can be retrieved, manipulated, created, or stored by the one or more processor(s) **72**B. The data **72**E can include, for instance, data to facilitate performance of the method **300** described herein. The data **72**E can be stored in one or more database(s). The one or more database(s) can be connected to computing system **72** by a high bandwidth LAN or WAN, or can also be connected to the computing system **72** through network(s) (not shown). The one or more database(s) can be split up so that they are located in multiple locales. In some implementations, the data **72**E can be received from another device.
- (120) The computing device(s) **72**A can also include a communication module or interface **72**F used to communicate with one or more other component(s) of computing system **72** or the additive manufacturing apparatus **10** over the network(s). The communication interface **72**F can include any suitable components for interfacing with one or more network(s), including, for example, transmitters, receivers, ports, controllers, antennas, or other suitable components.
- (121) As provided herein, the computing system **72** may be operably coupled with one or more of the drive system **30**, the material deposition assembly **46**, and/or the reclamation system **48**. The computing system **72** may be configured to control the actuation of the drive system **30** based on the information from one or more sensors **264**. Likewise, the computing system **72** may be operably coupled with the material deposition assembly **46** and/or the reclamation system **48** to actuate one or more respective components thereof.
- (122) Now that the construction and configuration of the additive manufacturing apparatus having one or more accumulators have been described according to various examples of the present subject matter,

a method **300** for operating an additive manufacturing apparatus is provided. In general, the method **300** will be described herein with reference to the additive manufacturing apparatus shown in FIGS. **1-16** and the various system components shown in FIG. **17**. However, it will be appreciated that the disclosed method **300** may be implemented with additive manufacturing apparatuses having any other suitable configurations and/or within systems having any other suitable system configuration. In addition, although FIG. **18** depicts steps performed in a particular order for purposes of illustration and discussion, the methods discussed herein are not limited to any particular order or arrangement. One skilled in the art, using the disclosures provided herein, will appreciate that various steps of the methods disclosed herein can be omitted, rearranged, combined, and/or adapted in various ways without deviating from the scope of the present disclosure.

- (123) Referring now to FIG. **18**, at step **302**, the method **300** includes operably coupling a bracket of a first vessel with a brace of said additive manufacturing apparatus. As provided herein, the brace may be operably coupled with a frame of the manufacturing apparatus and the bracket may be coupled with the first vessel. Further, the bracket can define an upper support and a lower support with the lower support positioned above the brace in the Z-axis direction. In some instances, the brace can define a locator pin and the lower support can define a locating void. In such instances, operably coupling a bracket of a first vessel with a brace may include positioning the locating void of the bracket about the locator pin of the brace.
- (124) Next, at step **304**, the method **300** includes coupling a conduit to direct resin within the first vessel to a reservoir. The reservoir can be configured to retain a first volume of the resin therein and define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction. The vessel can be positioned above the reservoir in a Z-axis direction and configured to store a second volume of the resin.
- (125) At step **306**, the method **300** includes actuating a regulator to allow the resin to be gravity fed from the first vessel to the reservoir. At step **308**, the method **300** can include detecting, with a sensor, a first volume of the resin within the reservoir. The regulator may be actuated when the first volume of the resin is below a predefined range. In various embodiments, the resin may be gravity fed from the first vessel to the reservoir to generally prevent the introduction of air to the resin R as the air is transferred into and/or through the conduit to the reservoir.
- (126) At step **310**, the method **300** includes depositing, with a material deposition assembly, the resin to form a deposited resin layer on a resin surface. In various instances, the resin surface can include at least a portion that is transparent. The material deposition assembly may be any device or combination of devices that is operable to apply a layer of the resin on the resin support. The material deposition assembly may optionally include a device or combination of devices to define a height of the resin on the resin support and/or to level the resin on the resin support. Nonlimiting examples of suitable material deposition assemblies include chutes, hoppers, pumps, spray nozzles, spray bars, or printheads (e.g. inkjets).
- (127) At step **312**, the method **300** includes executing a build cycle. In various embodiments, the build cycle can include positioning a stage relative to the resin surface so as to define a layer increment in the deposited resin layer, selectively curing the resin using an application of radiant energy in a specific pattern so as to define the geometry of a cross-sectional layer of the component, and/or moving the resin surface and the stage relatively apart so as to separate the component from the resin surface. (128) At step **314**, the method **300** can include removing a portion of the resin from the resin support through a collection structure. Moreover, at step **316**, the method can include directing the portion of the resin from the collection structure to a second vessel through a conduit.
- (129) It should be appreciated that the additive manufacturing apparatus is described herein only for the purpose of explaining aspects of the present subject matter. In other example embodiments, the additive manufacturing apparatus may have any other suitable configuration and may use any other suitable additive manufacturing technology. Further, the additive manufacturing apparatus and processes or methods described herein may be used for forming components using any suitable material. For example, the material may be plastic, metal, concrete, ceramic, polymer, epoxy, photopolymer resin, or any other suitable material that may be embodied in a layer of slurry, resin, or any other suitable form

of sheet material having any suitable consistency, viscosity, or material properties. For example, according to various embodiments of the present subject matter, the additively manufactured components described herein may be formed in part, in whole, or in some combination of materials including but not limited to pure metals, nickel alloys, chrome alloys, titanium, titanium alloys, magnesium, magnesium alloys, aluminum, aluminum alloys, iron, iron alloys, stainless steel, and nickel or cobalt-based superalloys (e.g., those available under the name Inconel® available from Special Metals Corporation). These materials are examples of materials suitable for use in the additive manufacturing processes described herein, and may be generally referred to as "additive materials." (130) Further aspects are provided by the subject matter of the following clauses:

- (131) An additive manufacturing apparatus comprising: a stage configured to hold a component; a radiant energy device operable to generate and project radiant energy in a patterned image; an actuator configured to change a relative position of the stage relative to the radiant energy device; and a resin management system including a material deposition assembly upstream of the stage and configured to deposit a resin on a resin support, the material deposition assembly comprising: a reservoir configured to retain a first volume of the resin; a vessel separated from the reservoir and configured to store a second volume of the resin; and an impeller positioned within the vessel and configured to agitate the resin within the vessel.
- (132) The additive manufacturing apparatus of one or more of these clauses, wherein the reservoir is configured to define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction and a conduit configured to direct the resin from the vessel to the reservoir.
- (133) The additive manufacturing apparatus of one or more of these clauses, wherein the reservoir includes an upstream wall, a downstream wall, and sidewalls that define a cavity, and wherein the conduit is configured to direct resin into the cavity.
- (134) The additive manufacturing apparatus of one or more of these clauses, wherein the upstream wall defines a slot to receive the resin support and the downstream wall defines an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support.
- (135) The additive manufacturing apparatus of one or more of these clauses, wherein the material deposition assembly further comprises a regulator operably coupled with the conduit, the regulator configured to restrict flow of the resin from the vessel to the reservoir in a first position and allow flow from the vessel to the reservoir in a second position.
- (136) The additive manufacturing apparatus of one or more of these clauses, further comprising: a computing system operably coupled with the regulator and a volume sensor, the volume sensor configured to provide data to the computing system related to the first volume of the resin, and wherein the computing system actuates the regulator from the second position to the first position when the first volume of the resin deviates from a predefined range.
- (137) The additive manufacturing apparatus of one or more of these clauses, wherein the material deposition assembly further comprises a connector coupled with the upstream wall, the connector configured to maintain a portion of the conduit in a predefined position.
- (138) The additive manufacturing apparatus of one or more of these clauses, wherein the impeller is operably coupled with a rotation assembly, and wherein the rotation assembly is translatable in a Z-axis direction along a track assembly.
- (139) The additive manufacturing apparatus of one or more of these clauses, further comprising: a brace operably coupled with a frame of said manufacturing apparatus, wherein the material deposition assembly further comprises a bracket coupled with the vessel, the bracket selectively coupled with the brace.
- (140) The additive manufacturing apparatus of one or more of these clauses, wherein the bracket defines an upper support and a lower support, and wherein the lower support is positioned above the brace in a Z-axis direction.
- (141) The additive manufacturing apparatus of one or more of these clauses, wherein the brace defines a locator pin and the lower support defines a locating void, and wherein the locating void configured to surround the locator pin.
- (142) A method of operating an additive manufacturing apparatus, the method comprising: operably

coupling a bracket of a first vessel with a brace of said additive manufacturing apparatus; coupling a conduit to direct a resin within the first vessel to a reservoir; and actuating a regulator to allow the resin to be gravity fed from the first vessel to the reservoir.

- (143) The method of one or more of these clauses, further comprising: depositing, with a material deposition assembly, the resin to form a deposited resin layer on a resin surface, at least a portion of which is transparent.
- (144) The method of one or more of these clauses, further comprising: detecting, with a sensor, a volume of the resin within the reservoir, wherein actuating the regulator to allow the resin to be gravity fed from the first vessel to the reservoir occurs when the volume of the resin within the reservoir deviates from a predefined range.
- (145) The method of one or more of these clauses, further comprising: executing a build cycle, including the steps of: positioning a stage relative to a resin surface so as to define a layer increment in the resin; selectively curing the resin using an application of radiant energy in a specific pattern so as to define a cross-sectional layer of a component; and moving the resin surface and the stage relatively apart so as to separate the component from the resin surface.
- (146) The method of one or more of these clauses, further comprising: removing a portion of the resin from a resin support through a collection structure; and directing the portion of the resin from the collection structure to a second vessel through the conduit.
- (147) An additive manufacturing apparatus comprising: a stage configured to hold one or more cured layers of a resin that form a component; a radiant energy device positioned opposite to the stage such that it is operable to generate and project radiant energy in a patterned image; and a resin management system including a reclamation system downstream of the stage, the reclamation system comprising: a collection structure configured to remove at least a portion of the resin from a resin support; a vessel configured to retain the resin removed from the resin support; and an impeller positioned within the vessel and configured to agitate the resin within the vessel.
- (148) The additive manufacturing apparatus of one or more of these clauses, further comprising: first and second brackets operably coupled with opposite sides of the vessel.
- (149) The additive manufacturing apparatus of one or more of these clauses, further comprising: a first brace and a second brace each defining a locating pin, wherein the first and second brackets define locating voids that are configured to respectively surround the locating pin of the first brace and the locating pin of the second brace.
- (150) The additive manufacturing apparatus of one or more of these clauses, wherein the first and second brackets define locating voids that are configured to respectively surround locating pins of a carrier of a dolly.
- (151) This written description uses examples to disclose the concepts presented herein, including the best mode, and also to enable any person skilled in the art to practice the present disclosure, including making and using any devices or systems and performing any incorporated methods. The patentable scope of the present disclosure is defined by the claims, and may include other examples that occur to those skilled in the art. Such other examples are intended to be within the scope of the claims if they include structural elements that do not differ from the literal language of the claims, or if they include equivalent structural elements with insubstantial differences from the literal languages of the claims.

Claims

1. An additive manufacturing apparatus comprising: a stage configured to hold a component; a radiant energy device operable to generate and project radiant energy in a patterned image; a resin management system including a material deposition assembly upstream of the stage and configured to deposit a resin on a resin support, the material deposition assembly comprising: a reservoir configured to retain a first volume of the resin, wherein the reservoir defining an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support; a vessel separated from the reservoir and configured to store a second volume of the resin; an impeller positioned within the vessel and configured to agitate the resin within the vessel; a conduit configured to direct the resin from the vessel

to the reservoir; and a regulator operably coupled with the conduit, the regulator configured to restrict flow of the resin from the vessel to the reservoir in a first position and allow flow from the vessel to the reservoir in a second position; a restrictor operably coupled with the conduit upstream of the regulator, the restrictor configured to block a flow of the resin within the conduit between the vessel and the regulator when placed in a restricted position, the restrictor configured to maintain a blocked position while the conduit is disconnected from the regulator; and a computing system operably coupled with the regulator, the computing system configured to actuate the regulator from the second position to the first position when the first volume of the resin deviates from a predefined range.

- 2. The additive manufacturing apparatus of claim 1, further comprising: a volume sensor positioned upstream of the aperture and configured to provide data related to the first volume of the resin.
- 3. The additive manufacturing apparatus of claim 1, wherein the reservoir is configured to define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction.
- 4. The additive manufacturing apparatus of claim 3, wherein the reservoir includes an upstream wall, a downstream wall, and sidewalls that define a cavity, and wherein the conduit is configured to direct resin into the cavity.
- 5. The additive manufacturing apparatus of claim 4, wherein the upstream wall defines a slot to receive the resin support and the downstream wall defines an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support.
- 6. An additive manufacturing apparatus comprising: a frame; a stage operably coupled with the frame and configured to hold a component; a radiant energy device operable to generate and project radiant energy in a patterned image; an actuator configured to change a relative position of the stage relative to the radiant energy device; and a resin management system including a material deposition assembly upstream of the stage and configured to deposit a resin on a resin support, the material deposition assembly comprising: a reservoir operably coupled with the frame, the reservoir configured to retain a first volume of the resin; a vessel separated from the reservoir and operably coupled with the frame, the vessel configured to store a second volume of the resin vertically above the reservoir relative to the frame; an impeller positioned within the vessel and configured to agitate the resin within the vessel; and a conduit configured to direct the resin from the vessel to the reservoir, the conduit positioned below the vessel and above the reservoir in a vertical direction.
- 7. The additive manufacturing apparatus of claim 6, wherein the reservoir is configured to define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction.
- 8. The additive manufacturing apparatus of claim 7, wherein the reservoir includes an upstream wall, a downstream wall, and sidewalls that define a cavity, and wherein the conduit is configured to direct resin into the cavity.
- 9. The additive manufacturing apparatus of claim 8, wherein the upstream wall defines a slot to receive the resin support and the downstream wall defines an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support.
- 10. The additive manufacturing apparatus of claim 7, wherein the material deposition assembly further comprises a regulator operably coupled with the conduit, the regulator configured to restrict flow of the resin from the vessel to the reservoir in a first position and allow flow from the vessel to the reservoir in a second position.
- 11. The additive manufacturing apparatus of claim 10, further comprising: a computing system operably coupled with the regulator and a volume sensor, the volume sensor configured to provide data to the computing system related to the first volume of the resin, and wherein the computing system actuates the regulator from the second position to the first position when the first volume of the resin deviates from a predefined range.
- 12. The additive manufacturing apparatus of claim 8, wherein the material deposition assembly further comprises a connector coupled with the upstream wall, the connector configured to maintain a portion of the conduit in a predefined position.
- 13. The additive manufacturing apparatus of claim 6, wherein the impeller is operably coupled with a rotation assembly, and wherein the rotation assembly is translatable in a Z-axis direction along a track assembly.

- 14. The additive manufacturing apparatus of claim 10, further comprising: a restrictor operably coupled with the conduit and configured to block a flow of the resin within the conduit past the restrictor when placed in a restricted position.
- 15. The additive manufacturing apparatus of claim 14, wherein the restrictor is upstream of the regulator.
- 16. An additive manufacturing apparatus comprising: a stage configured to hold a component; a radiant energy device operable to generate and project radiant energy in a patterned image; a resin management system including a material deposition assembly upstream of the stage and configured to deposit a resin on a resin support, the material deposition assembly comprising: a reservoir configured to retain a first volume of the resin, the reservoir defining an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support; a vessel separated from the reservoir and configured to store a second volume of the resin; an impeller positioned within the vessel and configured to agitate the resin within the vessel; a conduit configured to direct the resin from the vessel to the reservoir; and a regulator operably coupled with the conduit, the regulator configured to restrict flow of the resin from the vessel to the reservoir in a first position and allow flow from the vessel to the reservoir in a second position; a volume sensor positioned upstream of the aperture and configured to provide data related to the first volume of the resin; a thickness sensor configured to determine a thickness of the resin on the resin support, the thickness sensor downstream of the reservoir; and a computing system operably coupled with the regulator, the computing system configured to actuate the regulator from the second position to the first position when the first volume of the resin deviates from a predefined range based on data from the volume sensor and the thickness sensor.
- 17. The additive manufacturing apparatus of claim 16, wherein the material deposition assembly further comprises a connector coupled with the upstream wall, the connector configured to maintain a portion of the conduit in a predefined position.
- 18. The additive manufacturing apparatus of claim 16, wherein the reservoir is configured to define a thickness of the resin on the resin support as the resin support is translated in an X-axis direction.
- 19. The additive manufacturing apparatus of claim 18, wherein the reservoir includes an upstream wall, a downstream wall, and sidewalls that define a cavity, and wherein the conduit is configured to direct resin into the cavity.
- 20. The additive manufacturing apparatus of claim 19, wherein the upstream wall defines a slot to receive the resin support and the downstream wall defines an aperture that serves as an outlet for the resin support and a layer of the resin deposited on the resin support.